

# UM12180

## NAFE33352 evaluation board user manual

Rev. 1.0 — 13 February 2025

User manual

### Document information

Information	Content
Keywords	SPI-bus, NAFE33352, analog front-end, ADC, RTD, TC
Abstract	The NAFE33352 evaluation board is designed to test NAFE33352, which is a software configurable universal input/output AFE that meets high-precision measurement and control requirements for industrial-grade applications. The device is composed of a precision a 14/16/18-bit DAC and a 16/24-bit ADC, low-drift voltage reference, low-offset drift buffers, high-voltage, high-precision amplifiers. This evaluation board, along with the LPC54S018 MCU (with custom firmware) board, provides an easy-to-use evaluation platform.



**CAUTION**

This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling. You must use a ground strap or touch the PC case or other grounded source before unpacking or handling the hardware.

## 1 Introduction

The NAFE33352 evaluation board is designed to test the NAFE33352, which is a software-configurable universal analog input and output (AIO) analog front-end (AFE) that meets high-precision measurement and control requirements of industrial-grade applications.

The NAFE33352's highly integrated and system architecture includes a precision 14/16/18-bit digital-to-analog converter (DAC) and a 16/24-bit analog-to-digital converter (ADC), a low-drift voltage reference, low-offset drift buffers, and high-voltage and high-precision amplifiers with a 70 V input-protection circuit for EMC and miswiring scenarios, enabling software-configurable universal analog inputs and outputs. This evaluation board, along with the LPC54S018 MCU (with custom firmware) board, provides an easy-to-use evaluation platform.

A graphical interface allows the user to explore the different functions of the driver. The integrated circuit (IC) communicates to the host via the industry-standard SPI bus port. The evaluation software runs under Microsoft Windows 7, 8, and 10 PC platforms.

## 2 Finding the kit resources and information on the NXP web site

NXP Semiconductors provides online resources for this evaluation board and its supported device(s) on <http://www.nxp.com>.

The information page for the NAFE33352 evaluation board is at <https://www.nxp.com/NAFE33352>. The information page provides overview information, documentation, software and tools, parametrics, ordering information and a Getting Started tab. The Getting Started tab provides quick-reference information applicable to using the NAFE33352 evaluation board, including the downloadable assets referenced in this document.

## 3 Getting ready

### 3.1 Kit contents

The KIT-NAFE33352EVB contents include:

- Assembled and tested evaluation board in an antistatic bag
- USB cable
- 24 V AC-DC power adapter
- Ferrite block for power adapter
- LPC54S018EVB with NAFE firmware (included in KIT flavor)

### 3.2 Assumptions

Familiarity with the SPI-bus is helpful, but not required.

### 3.3 Minimum system requirements

- PC Pentium processor (or equivalent)
- One USB port (either 3.0 or 2.0 compatible)
- Windows 7, 8, or 10
- LPC54S018-EVB MCU evaluation board (from [www.nxp.com](http://www.nxp.com))

### 3.4 Power requirements

For the NAFE33352 setup, connect the PC to USB port J2 out of the three USB ports J1, J2 and J3 to power up the LPC54S018-EVB MCU evaluation board.

## 4 Getting to know the hardware

### 4.1 Kit overview

The NAFE33352 evaluation kit includes an NAFE33352 evaluation board, an LPC54S018 evaluation board with custom firmware, and a USB cable.

Use the following steps to set up the hardware:

1. Firmly connect the NAFE33352-EVK (AIO-AFE) evaluation board to the LPC54S018 (microcontroller) evaluation board using the Arduino connectors.
2. To connect both boards, slide the J200, J202, J204, and J206 male connectors at the bottom side of the NAFE33352-EVK (AIO-AFE) board into the appropriate female connectors on the LPC54S018 (microcontroller) board.
3. Plug in the supplied 24 V AC-DC power adapter to J308 to power up the device. Install the ferrite block at the end of the AC-DC power cable (where it makes connection to the NAFE33352-EVB) to maintain EMC compliance. Make sure J309, J310, and J311 are jumped for 2-3 position (south).
4. Apply AVDD/DVDD = 3.75 V on J300, HVDD = 15.4 V on J301, and HVSS = -15.4 V on the J302 banana jack connectors and turn on the power supply.
5. Connect the USB to the  $\mu$ USB cable between the USB port of the computer and the J2 ( $\mu$ USB) port of the LPC54S018 evaluation board.

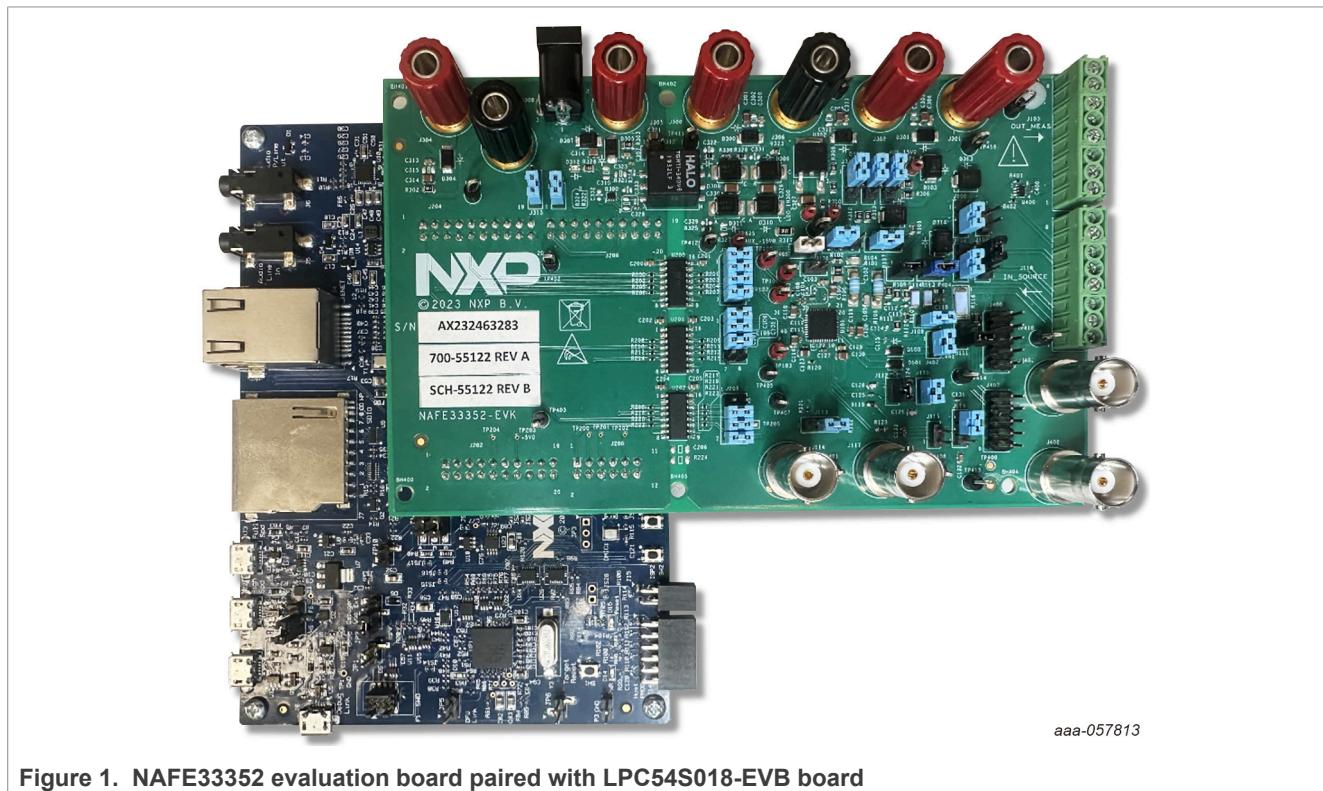
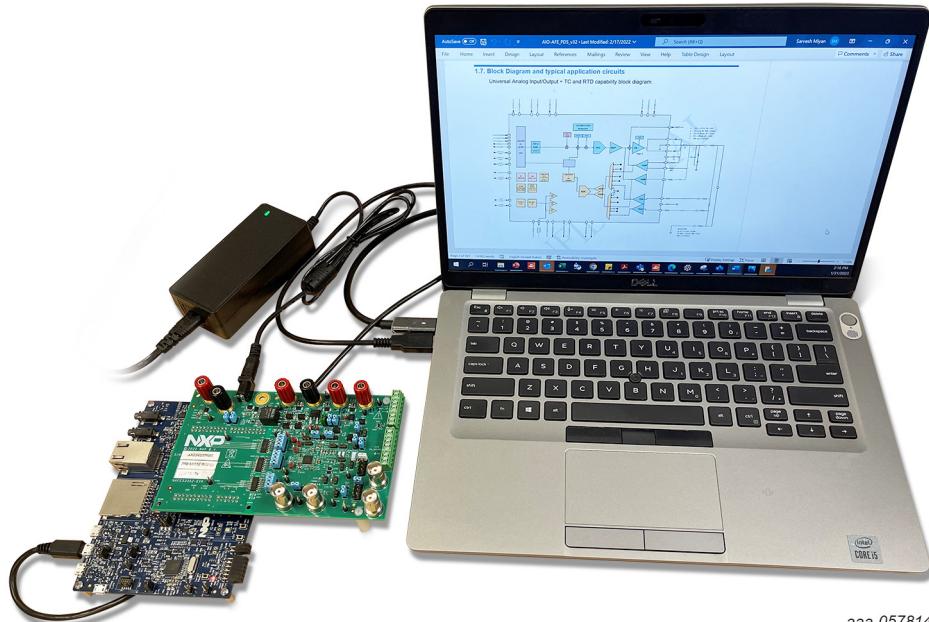


Figure 1. NAFE33352 evaluation board paired with LPC54S018-EVB board



aaa-057814

Figure 2. NAFE33352 evaluation board paired with LPC54S018-EVB board

## 4.2 Kit featured components

Table 1. NAFE33352 evaluation board main components

Device	Description	Location
NAFE33352	SW-configurable universal AIO-AFE	U101
MAX13256ATB	Transformer driver	U303
TGMR-340V6LF	Transformer	U301
MAX14930	Four-channel unidirectional digital isolators	U201
MAX14432	Four-channel bidirectional digital isolators	U202
MAX6126	Low-noise voltage reference	U300
CMLDM7002AG	N-channel MOSFET	Q300
LP2950ACDT-3P3RG	3.3 V LDO	U302

#### 4.2.1 Jumpers

**Table 2. Jumper settings for external power supply (3.75 V, 15.4 V, -15.4 V)**

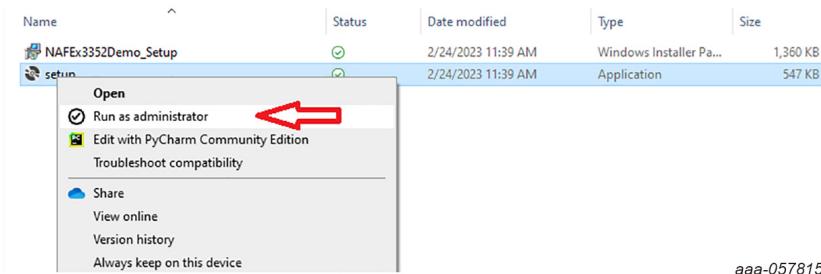
Setting	Jumper	Comment
EXT_3V3	J310 pin 1 – 2	External 3.3 V power selection
EXT_-15V0	J311 pin 1 – 2	External -15 V power selection
EXT_15V0	J309 pin 1 – 2	External 15 V power selection

**Table 3. Jumper settings for AC-DC adapter/transformer power supply (3.75 V, 15.4 V, -15.4 V)**

Setting	Jumper	Comment
3V3_LDO	J310 pin 2 – 3	AC-DC adapter/transformer 3.3 V power selection
TX_-15V0	J311 pin 2 – 3	AC-DC adapter/transformer -15 V power selection
TX_15V0	J309 pin 2 – 3	AC-DC adapter/transformer 15 V power selection

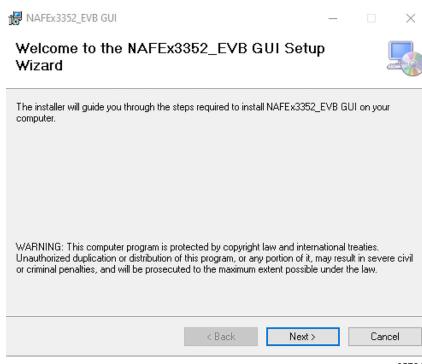
## 5 Tool interface (GUI) description

1. GUI Installation
2. Unzip the NAFE33352GUI\_installer zip file using the a compression utility, such as WinZip, WinRAR or 7z. Two files with type – “Windows Installer Package” and “Application” will be shown.

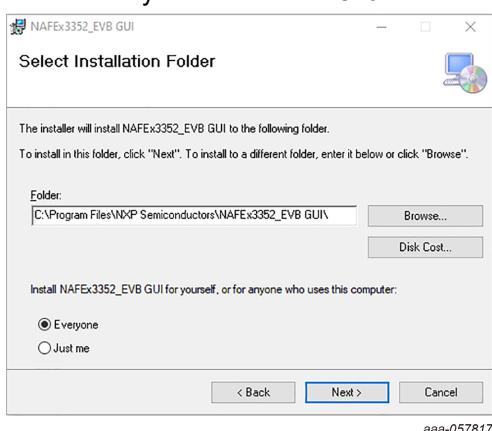


3. Right click on the **setup** application and click **Run** as administrator. Follow the prompts to install the application.

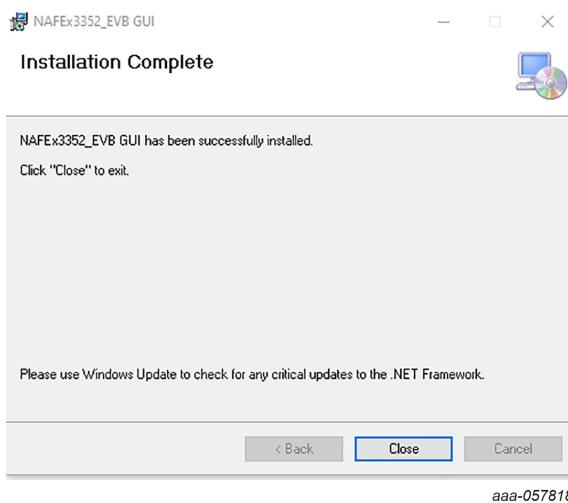
4. Click **Next**.



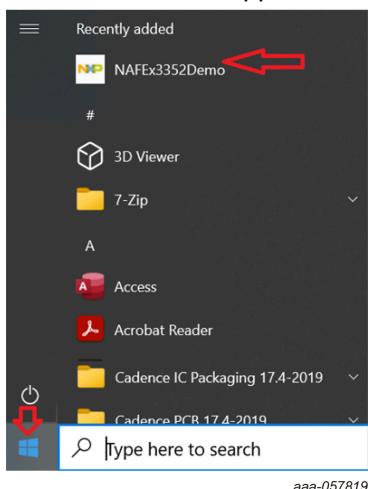
5. Select Everyone and click **Next**.



6. Click **Close**.



7. On central command, write NAFE and click the Windows start button at the bottom left. The NAFE3352Demo application will be shown.



## 5.1 Connectivity check

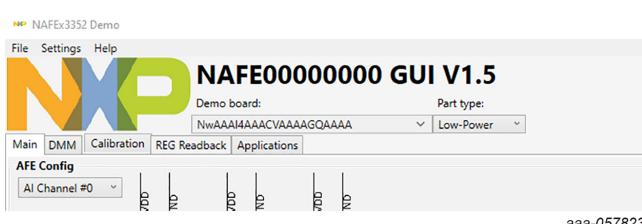
1. Click on **NAFEx3352 Demo** to open the GUI. If the connection is successful, the user should see on the GUI the MCU board address, the NAFE part number, and type (low-power or high-speed).



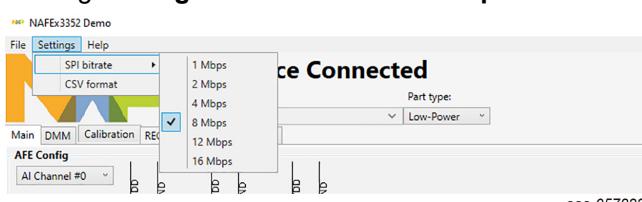
2. In the absence of proper power to the LPC board or the NAFE33352 EVB, the GUI won't be able to read back the MCU board address or NAFE part number/type. The GUI has dynamic indicator (marked by a red rectangle below the NXP logo) to show the status of the MCU board connectivity. If it displays **Disconnected**, it means that there is some issue with MCU board connectivity. Check the USB cable connection.



3. NAFE00000000 means the evaluation board is disconnected. Disconnect and reconnect the J2 (μUSB) port of the LPC54S018 evaluation board. The correct NAFE number should be appear as visible in step 1.



4. The GUI software sets the SPI clock rate to 8Mhz on power up. The SPI clock rate can be changed by clicking **Settings** → **SPI bitrate** → **8 Mbps**.



## 5.2 Using the tool

### 5.2.1 GUI

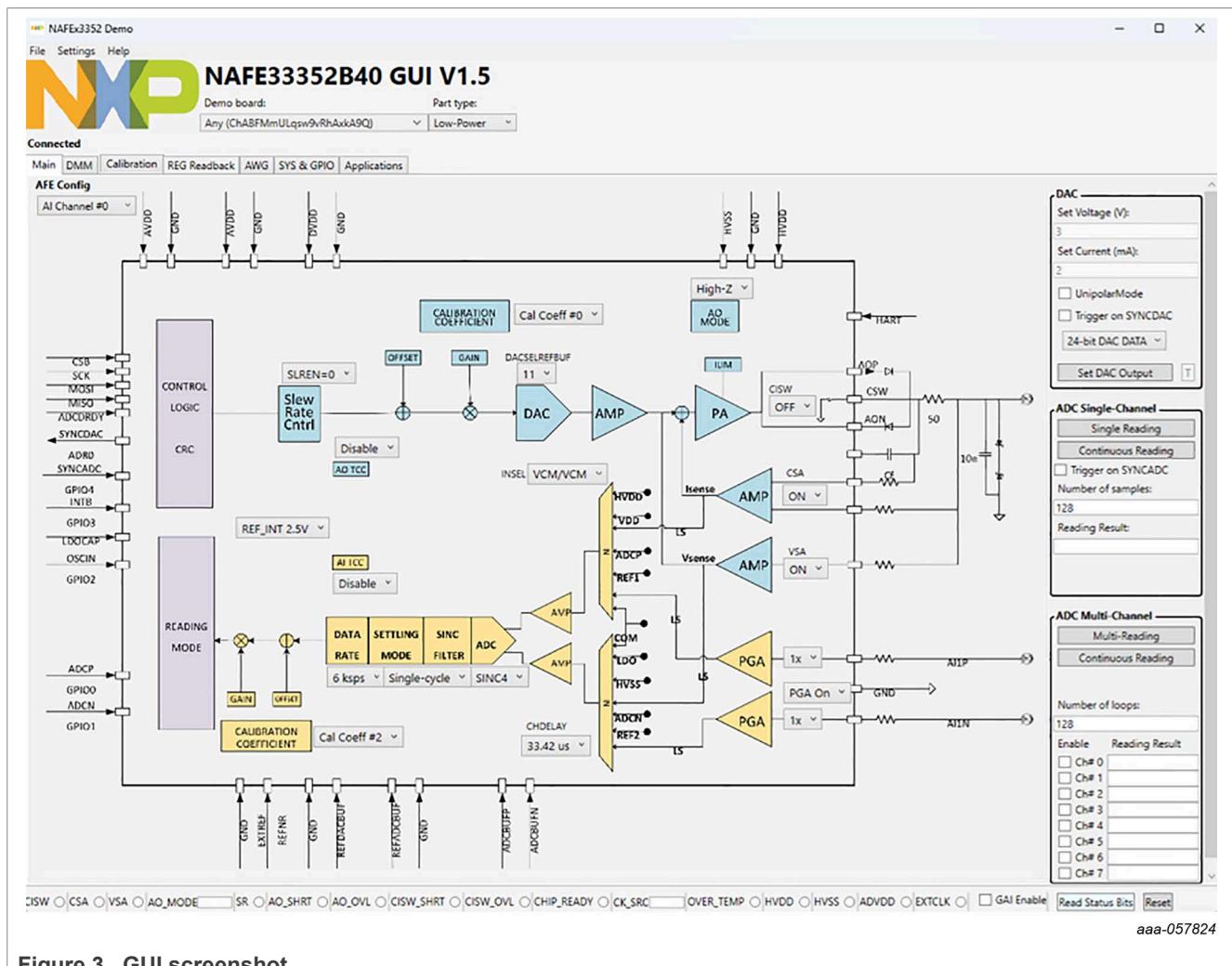


Figure 3. GUI screenshot

Opening the GUI will have a default configuration for all parameters.

The main blocks present on the GUI are ADC and DAC.

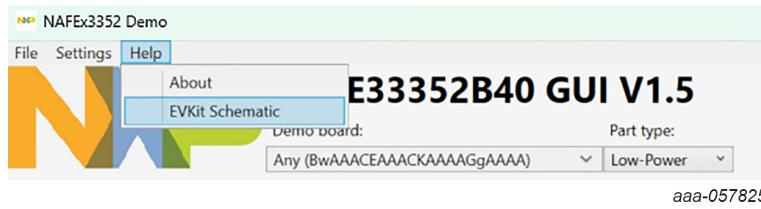
The ADC block (yellow) allows the user to select analog input settings: PGA gain, input selection, data rate, sinc filter, channel delay, and so on. The actual configuration of the device analog input registers to these selection happens when the user initiates a conversion/reading (single or continuous).

The DAC block (blue) allows the selection of the analog output: slew rate, AIO mode, (Vout/Cout/high-Z), CISW, CSA, and VSA. The user selection is configured and the output is generated at the press of **Set DAC Output**.

### 5.2.2 Schematic shortcut

It is possible to open the EVKit Schematic directly from the GUI using the menu bar.

Click **Help → EVKit Schematic**.

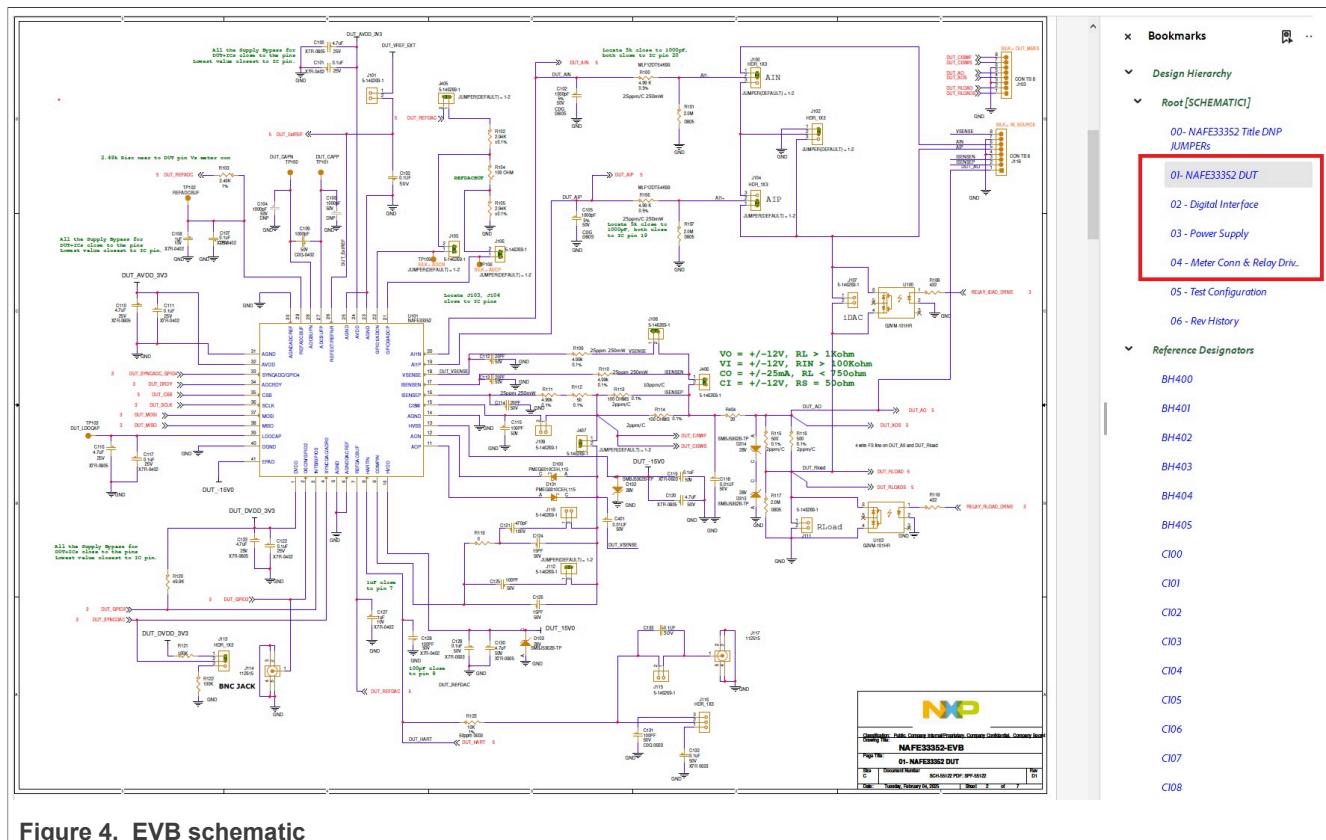


Clicking **EVKit Schematic** will open the schematic in pdf format as shown in [Figure 4](#).

The EVKit schematic provides a detailed blueprint of the electrical components and their interconnections within the evaluation kit. The peripheral and signal-chain components on both Analog Input/Output channels are selected to meet the accuracy/temperature operating requirements of the NAFE33352.

The EVKit schematic is divided into four sections to guide the user through understanding and using the kit.

1. NAFE33352 IC
2. Digital Interface
3. Power Supply
4. Measurement Connections and Relay Drivers



**Figure 4. EVB schematic**

### 5.2.3 Channel configuration

1. Select the channel gain using the dropdown menu of the programmable gain amplifier (PGA).

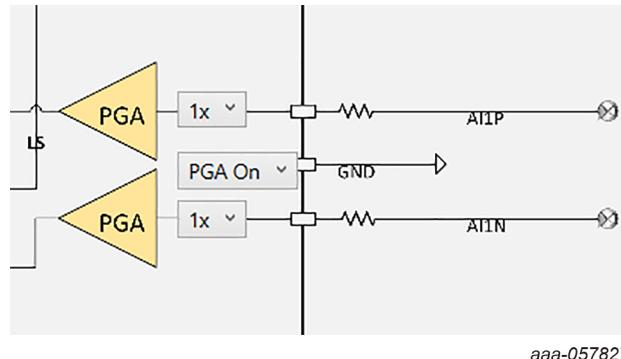


Figure 5. Analog Input PGA configuration

2. Configure the data rate, SINC filter order, and Settling mode via the corresponding dropdown menu of the ADC.

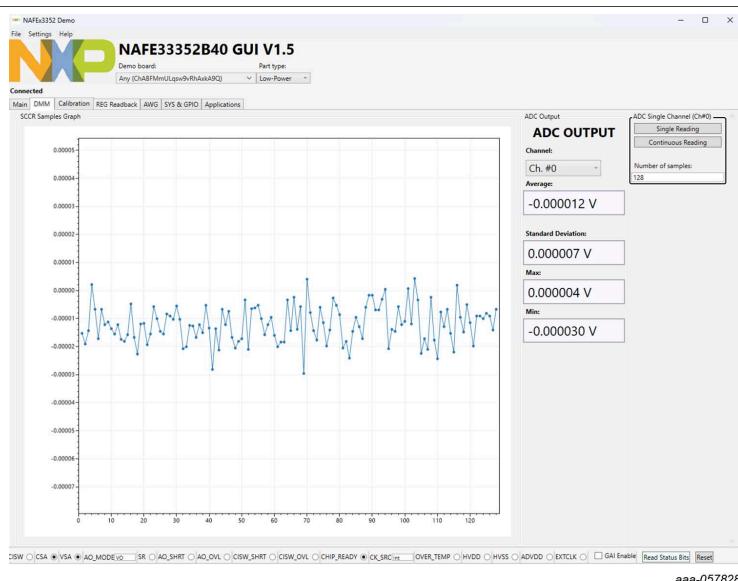


Figure 6. Analog input data rate, Settling mode, and sinc filter

### 5.2.4 Conversion modes

Five types of reading (conversion) modes are possible from the device:

1. Single-Channel Single-Reading (CMD\_SS)
2. Single-Channel Continuous Reading (CMD\_SC)
3. Multichannel Single-Reading (CMD\_MS) (available in future revision)
4. Multichannel Multireading (CMD\_MM)
5. Multichannel Continuous Reading (CMD\_MC)

Refer to the data sheet for more about these conversion modes.

1. Single-Channel Single-Reading
  - Click the **Single Reading** button after picking Inputs under test from the MUX drop-down menu.

- Read the input voltage on Reading Result box.

2. Single-Channel Continuous Reading
  - Enter the number of samples required in the box and click **Continuous Reading**. Once **Continuous Reading** is clicked, a dialog box will open to pick a folder to create a .csv conversion results file on the hard drive with the number of samples requested.
3. Multichannel Multireading
  - Preconfigure appropriate channels to be sequenced using the AFE configuration dropdown menu and enable those channel numbers accordingly under the Multi-Channel section at the bottom right of the GUI.
  - Click **Multireading**.
  - Read the input voltages in Reading Result multibox.
4. Multichannel Continuous Reading
  - Preconfigure the appropriate channels to be sequenced using the AFE configuration dropdown menu and enable those channel numbers under the Multichannel section at the bottom right of the GUI.
  - Click **Continuous Reading** and wait for the dialog box to pick the folder to create a .csv conversion results file on the hard drive with the number of samples requested.

### 5.2.5 Data-rate selection

The AI-AFE provides a flexible ADC configuration that enables the user to configure Settling mode, digital SINC filter, and data rate. As reported in the data rate table, the data-rate output is a function of the combination of Settling mode, digital SINC filter, and data rate.

The easier way to configure the AI-AFE is:

1. Select the Settling mode (normal or single cycle)
2. Select the digital SINC filter
3. Select the data rate

For example, to select 9000 sps in Single-Cycle Settling mode and SINC4:

Table 4. ADC data rate (system clock: 4.608 MHz)

DRO code	OSR	Normal settling						Single-cycle settling					
		SINC4	SINC4+ SINC1	SINC4+ SINC2	SINC4+ SINC3	SINC4+ SINC4	SINC4	SINC4+ SINC1	SINC4+ SINC2	SINC4+ SINC3	SINC4+ SINC4	SINC4+ SINC4	
0	8	288000					72000						
1	12	192000					48000						
2	16	144000					36000						
3	24	96000					24000						
4	32	72000					18000						
5	48	48000					12000						
6	64	36000					9000						
7	96	24000					6000						
8	128	18000					4500						
9	192	12000					3000						
10	256	9000					2250						
11	384	6000					1500						
12	512		4500.00	4500.00	4500.00	4500.00		2250.00	1500.00	1125.00	900.00		
13	768		3000.00	3000.00	3000.00	3000.00		1500.00	1000.00	750.00	600.00		
14	1024		2250.00	2250.00	2250.00	2250.00		1125.00	750.00	562.50	450.00		
15	2048		1125.00	1125.00	1125.00	1125.00		562.50	375.00	281.25	225.00		
16	4096		562.50	562.50	562.50	562.50		281.25	187.50	140.63	112.50		

**Table 4. ADC data rate (system clock: 4.608 MHz)...continued**

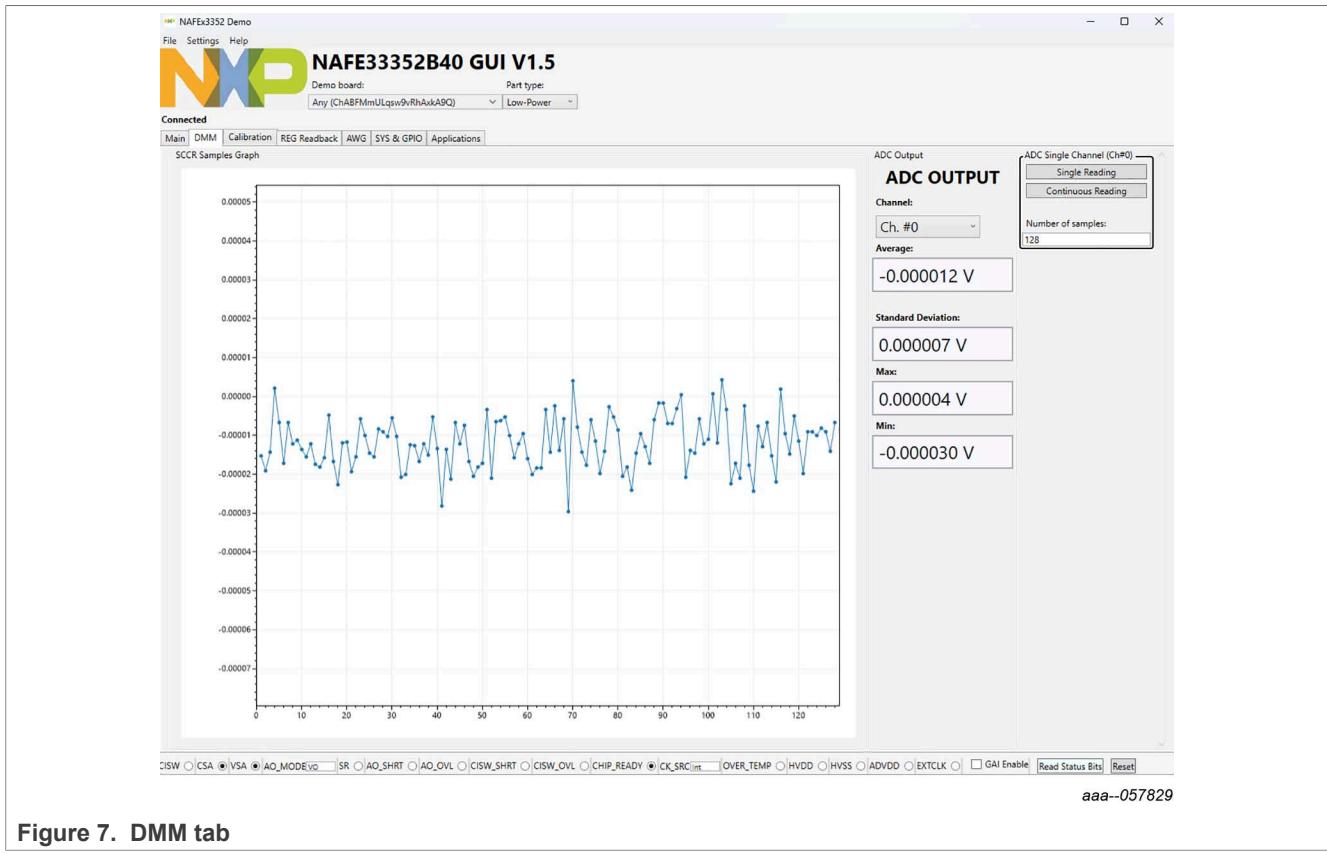
17	5760		400.00	400.00	400.00	400.00		200.00	133.33	100.00	80.00
18	7680		300.00	300.00	300.00	300.00		150.00	100.00	75.00	60.00
19	11520		200.00	200.00	200.00	200.00		100.00	66.67	50.00	40.00
20	23040		100.00	100.00	100.00	100.00		50.00	33.33	25.00	20.00
21	38400		60.00	60.00	60.00	60.00		30.00	20.00	15.00	12.00
22	46080		50.00	50.00	50.00	50.00		25.00	16.67	12.50	10.00
23	76800		30.00	30.00	30.00	30.00		15.00	10.00	7.50	6.00
24	92160		25.00	25.00	25.00	25.00		12.50	8.33	6.25	5.00
25	115200		20.00	20.00	20.00	20.00		10.00	6.67	5.00	4.00
26	153600		15.00	15.00	15.00	15.00		7.50	5.00	3.75	3.00
27	230400		10.00	10.00	10.00	10.00		5.00	3.33	2.50	2.00
28	307200		7.50	7.50	7.50	7.50		3.75	2.50	1.88	1.50

4. Select normal settling in the Settling mode dropdown menu.
5. Select SINC 4 in the filter dropdown menu.
6. Select 9000 sps in the data-rate dropdown menu.

## 5.2.6 DMM view tab

DMM tab shows SCCR (single-channel continuous read) with sample = 128 for selected logical channel. Below, Channel 0 is configured for VCM-VCM .

On DMM, it is possible to analyze the behavior of the signal and report the statistical information as Standard Deviation, Max, and Min.

**Figure 7. DMM tab**

### 5.2.7 SYS and GPIO tab

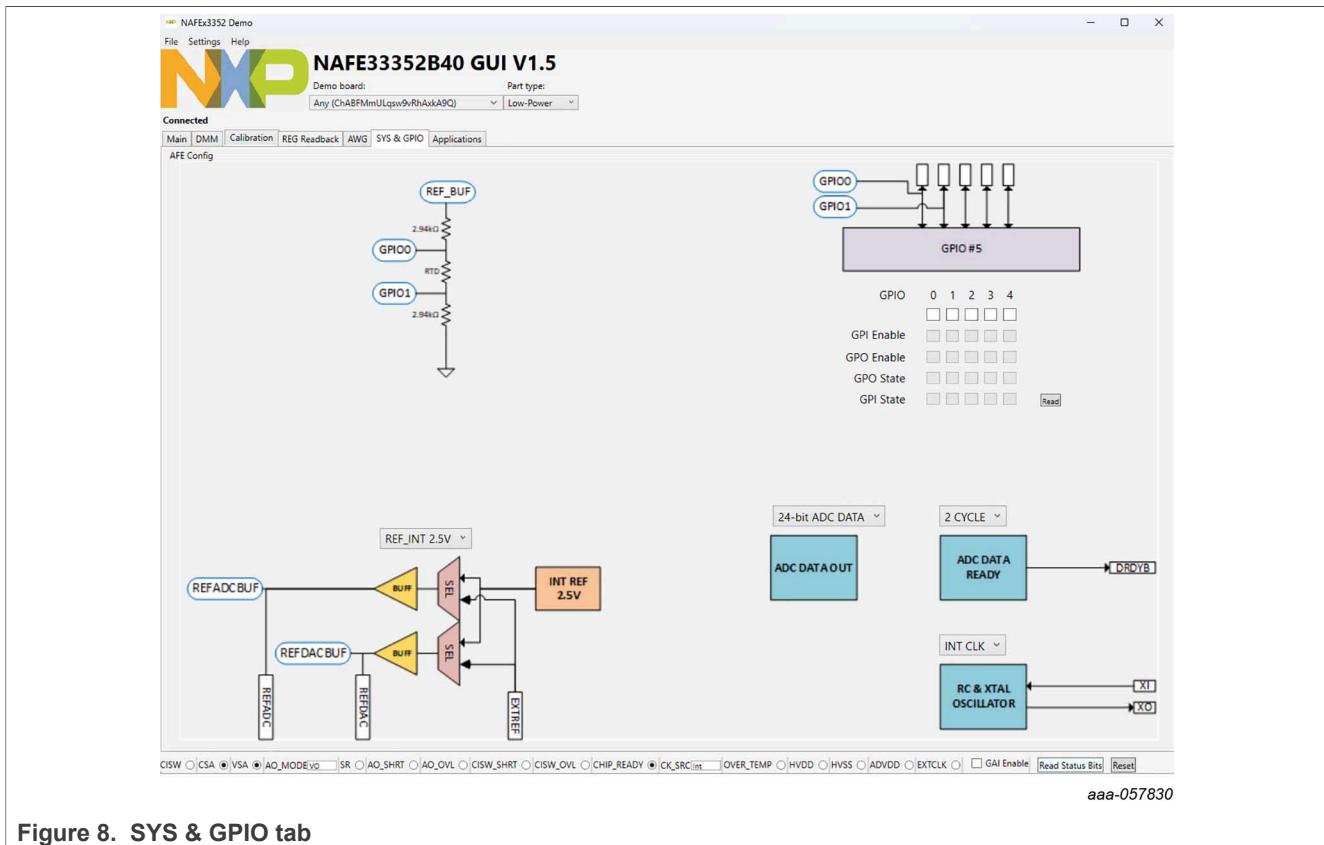


Figure 8. SYS & GPIO tab

This tab provides easy to use blocks to set system level selections like Internal Vs External Reference or Clock, GPIO functionality, and so on. The NAFE33352 includes five GPIOs with dual functionality.

The settings that are possible to change are:

- Reference selection for REF\_INT or REF\_EXT
- ADC Data BIT, 24 or 16 bits
- Clock selection: internal or external
- Data ready signal behavior in 2 cycle or 8 cycle
- GPIO0 and GPIO1 is shared with the ADCP and ADCN that serve as single-ended and differential analog input by setting LVMUX. The input common voltage range is from 0.5 V to 2.5 V.

The GPIOs are schematized on the GUI as an array of settings.

The bits that can be accessed from this matrix are:

- **Pin connect:** Should be enabled to use the connected pins as GPIOs.
- **GPI/GPO enable:** Depending on the desired functionality, GPI/GPO must be enabled.
- **GPO state:** Enable or disable this cell to put 1 or 0 on the selected GPIOs.
- **GPI state:** Click **Read** to update the cell states of the GPIOs set as Input.

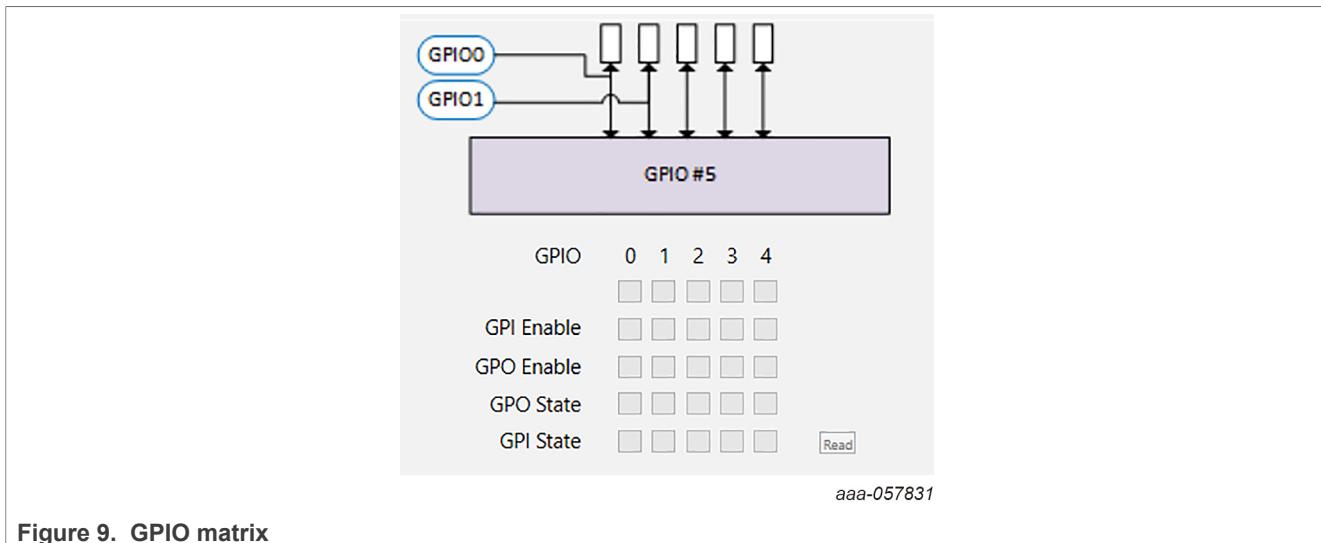


Figure 9. GPIO matrix

### 5.2.8 AWG tab

The AWG tab provides tools to generate custom waveforms. To create a waveform, adjust the following parameters:

- **AWGAMP\_MAX**: This sets the maximum amplitude of the waveform. (Default is 5 V)
- **AWGAMP\_MIN**: This sets the minimum amplitude of the waveform. (Default -5 V)
- **STEP AMP**: This defines the amplitude step size for each waveform segment.
- **STEP Freq**: This determines the duration of each waveform segment.
- **HILO TIME**: This specifies the time the waveform spends at the high and low amplitude levels within a segment.

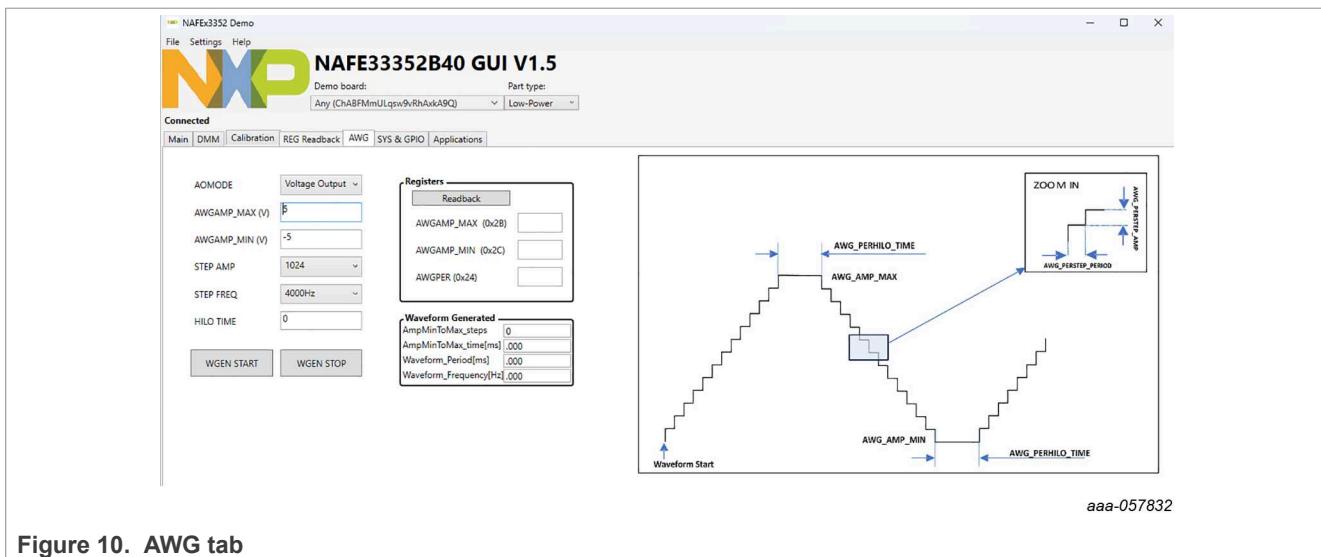


Figure 10. AWG tab

**Note:** For some instances with different programming **STEP\_AMP** value, **AWG\_AMP\_MAX**, or **AWG\_AMP\_MIN** value would not be possible to reach exactly. In these cases, the maximum, minimum code must be clamped to **AWG\_AMP\_MAX**, **AWG\_AMP\_MIN** value respectively.

$$\text{AMPmin to max steps} = (\text{Amp\_max} - \text{Amp\_min}) / (\text{step\_size} * \text{LSB})$$

$$\text{AMPmin to max time} = (\text{AMPmin to max steps}) / \text{step\_freq}$$

*Waveform\_period = 2\*(AMPmintomax\_time + HILO\_time)*

*Waveform\_freq = 1/Waveform\_period*

*For example:*

*For 18 bits LSB = (25)/2<sup>18</sup> = 95.367 uV*

*If Step\_size(Code = 0) = 1024, Amp\_max = 12.5 V, Amp\_min = -12.5 V then AMPmintomax\_steps = 256*

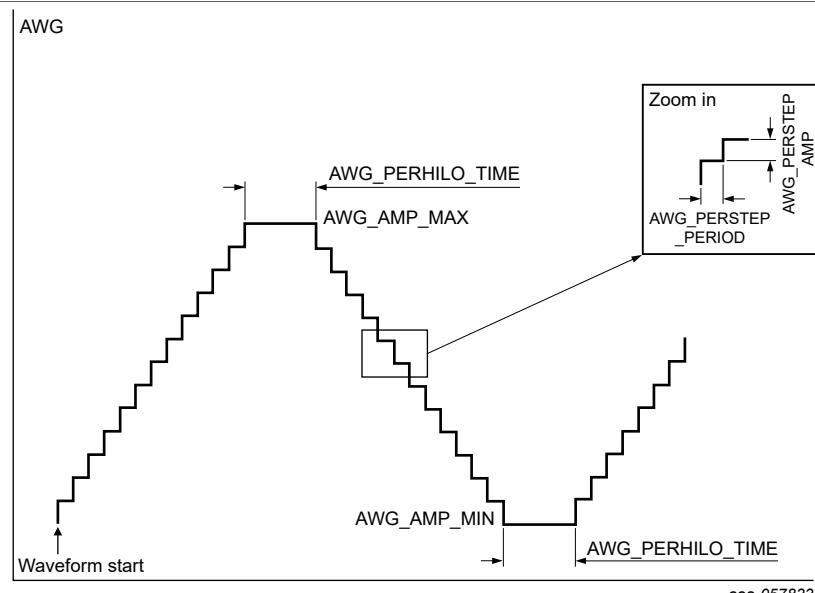
*If step\_period(code=0)=4000, then AMPmintomax\_time = 0.064 s*

*If HILO\_time = 0, then WF\_freq = 7.8125 Hz.*

**Table 5. Generated waveform frequency with HILO time = 0**

Generated waveform frequency (Hz)		STEP_Amp (18-bit)							
		0	1	2	3	4	5	6	7
Code	Step_period (Hz)	1024	2048	4096	8192	16384	32768	65536	131072
0	4000	7.8125	15.6250	31.2500	62.5000	125.0000	250.0000	500.0000	1000.0000
1	6000	11.7188	23.4375	46.8750	93.7500	187.5000	375.0000	750.0000	1500.0000
2	9000	17.5781	35.1563	70.3125	140.6250	281.2500	562.5000	1125.0000	2250.0000
3	12000	23.4375	46.8750	93.7500	187.5000	375.0000	750.0000	1500.0000	3000.0000
4	40000	78.1250	156.2500	312.5000	625.0000	1250.0000	2500.0000	5000.0000	10000.0000
5	60000	117.1875	234.3750	468.7500	937.5000	1875.0000	3750.0000	7500.0000	15000.0000
6	90000	175.7813	351.5625	703.1250	1406.2500	2812.5000	5625.0000	11250.0000	22500.0000
7	150000	292.9688	585.9375	1171.8750	2343.7500	4687.5000	9375.0000	18750.0000	37500.0000

The main buttons to generate the AWG are **WGEN START** and **WGEN STOP**. To start and stop the waveform generation, use **WGEN START** and **WGEN STOP**, respectively.



**Figure 11. AWG structure**

### 5.2.9 Register reading tab

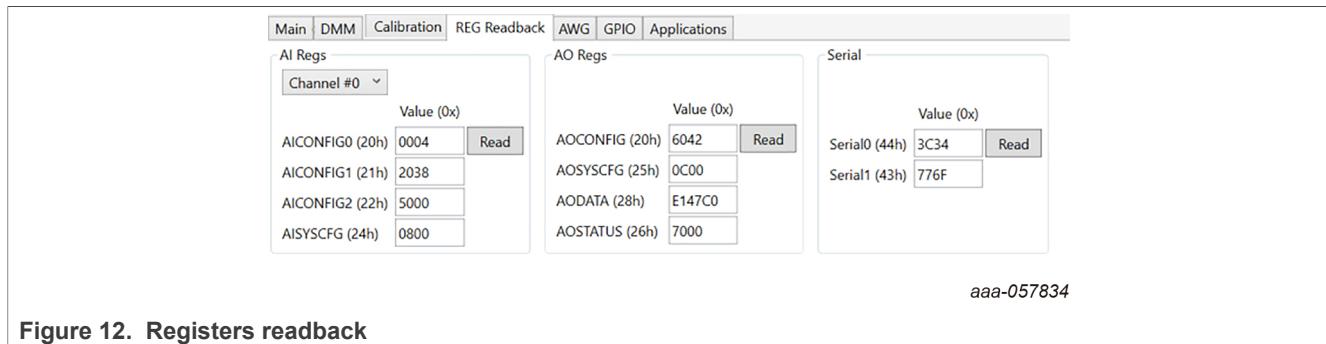


Figure 12. Registers readback

The Register Reading tab enables the user to read main block registers of the device - analog input channels/system configurations, analog output configuration/status/data, and device serial number for identification. The user can confirm both the AI and AO register configuration done in Main tab by clicking **Read** in REG Readback tab.

### 5.2.10 Calibration tab

Follow the instructions present in the Calibration tab to perform a calibration of the device. The selected Gain/Offset registers will be written and updated according to the procedure.

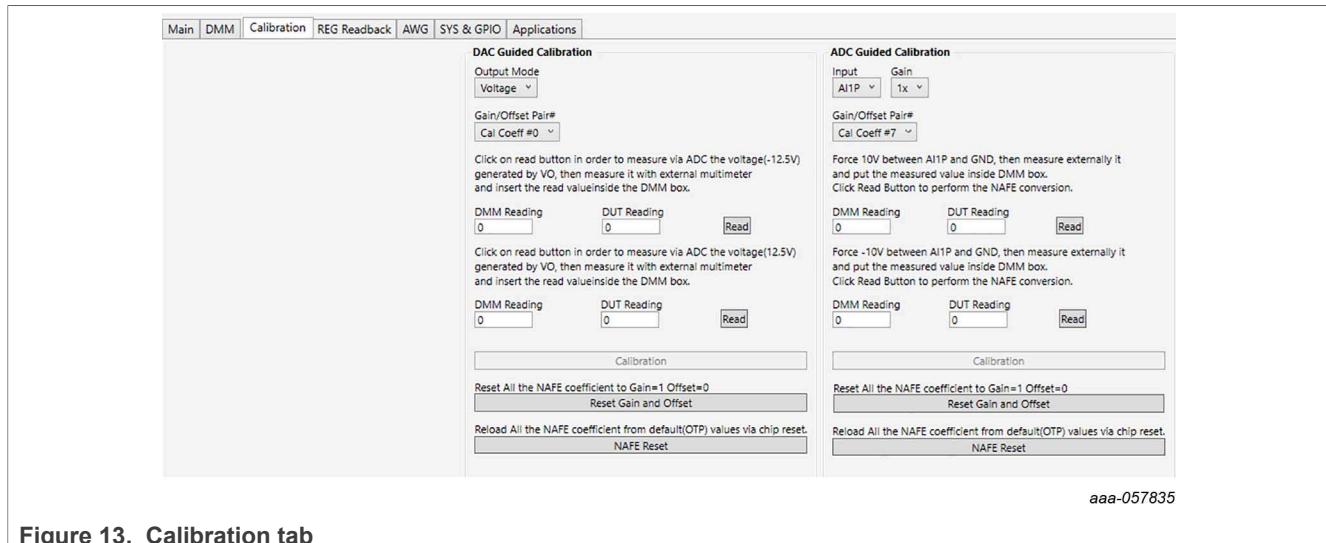


Figure 13. Calibration tab

### 5.2.11 Check alarm status

The AIO-AFE provides a flexible and configurable global alarm to allow the user to configure it based on the specific application and needs.

**Table 6. Alarm and interrupt**

GLOBAL ALARM ENABLE 0x32h	15	OVER_TEMP_ALRM	RW	0x0	Overtemperature warning at 145 °C.
	14	HVDD_ALRM	RW	0x0	Enable alarm for HVDD supply detect below preset threshold.
	13	HVSS_ALRM	RW	0x0	Enable alarm for HVSS supply detect below preset threshold.
	12	DVDD_ALRM	RW	0x0	Enable alarm for DVDD supply detect below preset threshold.
	11	Reserved	RW	0x0	Unused
	10	GPI_POS_ALRM	RW	0x0	Enable alarm for rising edge detected at any of the GPI pins.
	9	GPI_NEG_ALRM	RW	0x0	Enable alarm for falling edge detected at any of the GPI pins.
	8	CONFIG_ERROR_ALRM	RW	0x0	Enable alarm for register configuration error.
	7	OVRNG_ALRM	RW	0x0	Enable alarm when one or more data channels are overrange.
	6	UNDNG_ALRM	RW	0x0	Enable alarm when one or more data channels are underrange.
	5	OVRLOAD_ALRM	RW	0x0	Enable alarm when one or more data channels are overloaded or underloaded.
	4	EXTCLK_FREQ_ALRM	RW	0x0	Enable alarm when XTAL or EXTCLK frequency varies with internal CLK by XX.
	3	PGA_OV_ALRM	RW	0x0	Enable alarm when one or more data channels are overvoltage stressing the PGA.
	2	VIEX_OV_ALRM	RW	0x0	Enable alarm when excitation voltage source is overloaded.
	1	VIEX_OI_ALRM	RW	0x0	Enable alarm when excitation current source is overloaded.
	0	TEMP_ALRM	RW	0x0	Enable programmable temperature alarm, the triggering threshold is set in THRS_TEMP register bits.
GLOBAL ALARM INTERRUPT 0x33h	15	OVER_TEMP_INT	RW	0x0	Bit clear behavior is controlled by GLOBAL_ALRM_STICKY.
	14	HVDD_INT	RW	0x0	Bit clear behavior is controlled by GLOBAL_ALRM_STICKY.
	13	HVSS_INT	RW	0x0	Bit clear behavior is controlled by GLOBAL_ALRM_STICKY.
	12	DVDD_INT	RW	0x0	Bit clear behavior is controlled by GLOBAL_ALRM_STICKY.
	11	Reserved	RW	0x0	Unused
	10	GPI_POS_INT	RW	0x0	Bit clear behavior is controlled by GLOBAL_ALRM_STICKY.
	9	GPI_NEG_INT	RW	0x0	Bit clear behavior is controlled by GLOBAL_ALRM_STICKY.
	8	CONFIG_ERROR_INT	RW	0x0	Bit clear behavior is controlled by GLOBAL_ALRM_STICKY.
	7	OVRNG_INT	RW	0x0	Bit clear behavior is controlled by GLOBAL_ALRM_STICKY.
	6	UNDNG_INT	RW	0x0	Bit clear behavior is controlled by GLOBAL_ALRM_STICKY.
	5	OVRLOAD_INT	RW	0x0	Bit clear behavior is controlled by GLOBAL_ALRM_STICKY.
	4	EXTCLK_FREQ_INT	RW	0x0	Bit clear behavior is controlled by GLOBAL_ALRM_STICKY.
	3	PGA_OV_INT	RW	0x0	Bit clear behavior is controlled by GLOBAL_ALRM_STICKY.
	2	VIEX_OV_INT	RW	0x0	Bit clear behavior is controlled by GLOBAL_ALRM_STICKY.
	1	VIEX_OI_INT	RW	0x0	Bit clear behavior is controlled by GLOBAL_ALRM_STICKY.
	0	TEMP_INT	RW	0x0	Bit clear behavior is controlled by GLOBAL_ALRM_STICKY.

For device and input monitoring, various alarms and interrupts are available, including programmable alarm thresholds for (1) temperature alarm, (2) channel-based overrange and underrange alarms.

The alarm-clearing behavior is determined by GLOBAL\_ALRM\_STICKY. The ribbon at the bottom of the GUI displays common faults, such as short-circuit, overload, chip status, switch of current input, and the power supply (HVDD, HVSS, ADVDD) for users ease of operation and debug. The status ribbon stays on irrespective of the tab selected by the user. The user can check the latest status by clicking Read Status Bits and can reset the device when needed'.

The user must activate GAI Enable to read the alarm status of Over\_Temp, HVDD, HVSS, ADVDD, or EXTCLK in case of a fault occurrence.



**Figure 14. Alarm status**

### 5.2.12 Reset

The AFE has two types of Reset mode:

- Chip power-on reset (POR)
- Command RESET

The button for the Command RESET is available in the Status ribbon and Calibration tabs.

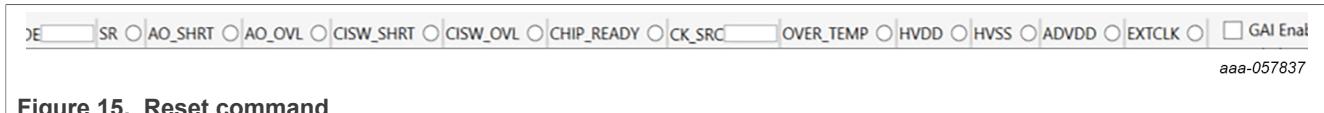


Figure 15. Reset command

When in reset, all HV input pins and GPIO pins are in high-Z Input mode, internal voltage reference is used, ADC digital filters are cleared, all user registers are set to their default values, and all OTP shadow register content will be reloaded.

### 5.2.13 ADC analog input channel configuration and testing

NAFE33352 has eight logical channels, which can be configured to route different internal signals (AVDD, HVDD, HVSS, REF\_Byp, and so on) and the external signals at AIP and AIN.

Table 7. Analog input selection

ANALOG INPUT SELECTION (AI_Config0 at address 0x20\h -> IN_SEL bits 7:3)					
S.No	IN_SEL	Input MUXP	Input MUXN	Measure type	Transfer function
0	00000	VCM	VCM	DIFF	$V_{vcm-vcm} = adc\_code*20*2.5/(12.5*2^24)$
1	00001	AI1P	AI1N	DIFF	$V_{aipn} = adc\_code*20*2.5/(Gain*2^24)$
2	00010	AI1P	VSNS	DIFF	$(V_{aip}-V_{sns})* PGA\_Gain = adc\_code*20*2.5/2^24$
3	00011	ADCP/GPIO0	ADCN/GPIO1	DIFF	$V_{gpio01} = adc\_code*20*2.5/(12.5*2^24)$
4	00100	AI1P	VCM	SE	$V_{aip} = adc\_code*20*2.5/(Gain*2^24)$
5	00101	VCM	AI1N	SE	$V_{ain} = adc\_code*20*2.5/(Gain*2^24)$
6	00110	ISNS	VCM	SE	$V_{isns} = adc\_code*20*2.5/(3.7989*2^24)$ , where CSA gain = 3.7989 with 5 kΩ external resistors.
7	00111	VCM	VSNS	SE	$V_{vsns} = adc\_code*20*2.5/2^24$ , where VSA gain = 1
8	01000	TIA	VCM	SE	$V_{tia} = adc\_code*20*2.5/(2.5*2^24)$
9	01001	ADCP/GPIO0	VCM	SE	$V_{gpio0} = adc\_code*20*2.5/(12.5*2^24) + 1.5$ (VCM voltage)
10	01010	VCM	ADCN/GPIO1	SE	$V_{gpio1} = adc\_code*20*2.5/(12.5*2^24) + 1.5$ (VCM voltage)
11	01011	REF_BYP	VCM	SE	$REF\_BYP = adc\_code*20*2.5/(12.5*2^24) + 1.5$ (VCM voltage) $\geq \sim 2.5$ V
12	01100	VCM	REF_BYP	SE	$REF\_BYP = (adc\_code-2^24)*20*2.5/(12.5*2^24) - 1.5$ (VCM voltage) $\geq \sim -2.5$ V
13	01101	VCM	BG	SE	$BG = (adc\_code-2^24)*20*2.5/(12.5*2^24) + 1.5$ (VCM voltage) where $adc\_code > 2^23 \geq \sim 1.25$ V
14	01110	VADD	VCM	SE	$V_{avdd} = adc\_code*20*2.5/(12.5*2^24) + 1.5$ (VCM voltage) $\geq \sim AVDD/2$
15	01111	VCM	LDO	SE	$LDO = adc\_code*20*2.5/(12.5*2^24) + 1.5$ (VCM voltage) $\geq \sim 1.8$ V
16	10000	VHDD	VCM	SE	$V_{vhdd} = adc\_code*20*2.5/(12.5*2^24) \geq \sim HVDD/40$
17	10001	VCM	VHSS	SE	$V_{vhss} = adc\_code*20*2.5/(12.5*2^24) \geq \sim HVSS/40$
18	10010	DAC_REF	VCM	SE	$V_{dac\_ref} = adc\_code*20*2.5/(12.5*2^24) + 1.5$ (VCM voltage) $\geq \sim 2.5$ V

The AFE Config dropdown menu shows selectable channel configurations (channel #0 - #7 config) to read the converted signal. (Default is AI Channel #0).

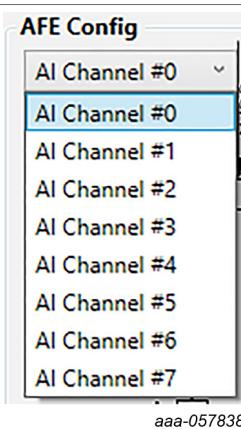


Figure 16. Channel configurations

It's possible to read the internal signal in:

1. ADC Single Channel:

- Single Reading,
- Continuous Reading

2. ADC Multichannel:

- Multireading,
- Continuous Reading

For more details, see [Section 5.2.4](#).

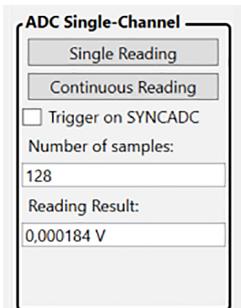


Figure 17. ADC Single-Channel

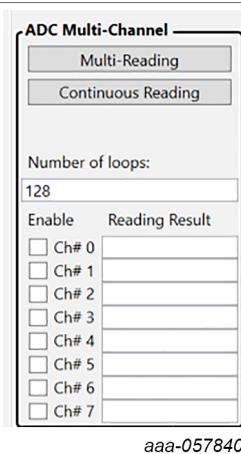


Figure 18. ADC Multi-Channel

### 5.2.14 Single-channel single-reading (SCSR) example

Example: Channel#0 is configured to read the internal VHDD signal. [Figure 19](#)

The steps to follow are:

1. Select the number of channels as AI Channel #0.
2. Select PGA, SINC FILTER, ADC SETTING MODE, ADC DATA RATE, CHANNEL PROGRAM DELAY, and CALIBRATION COEFFICIENT settings in the dropdown menus.
3. Set VHDD/VCM.
4. Set number of loops as 128 samples.
5. Click the Single Reading.
6. The result will be the average of 128 samples.

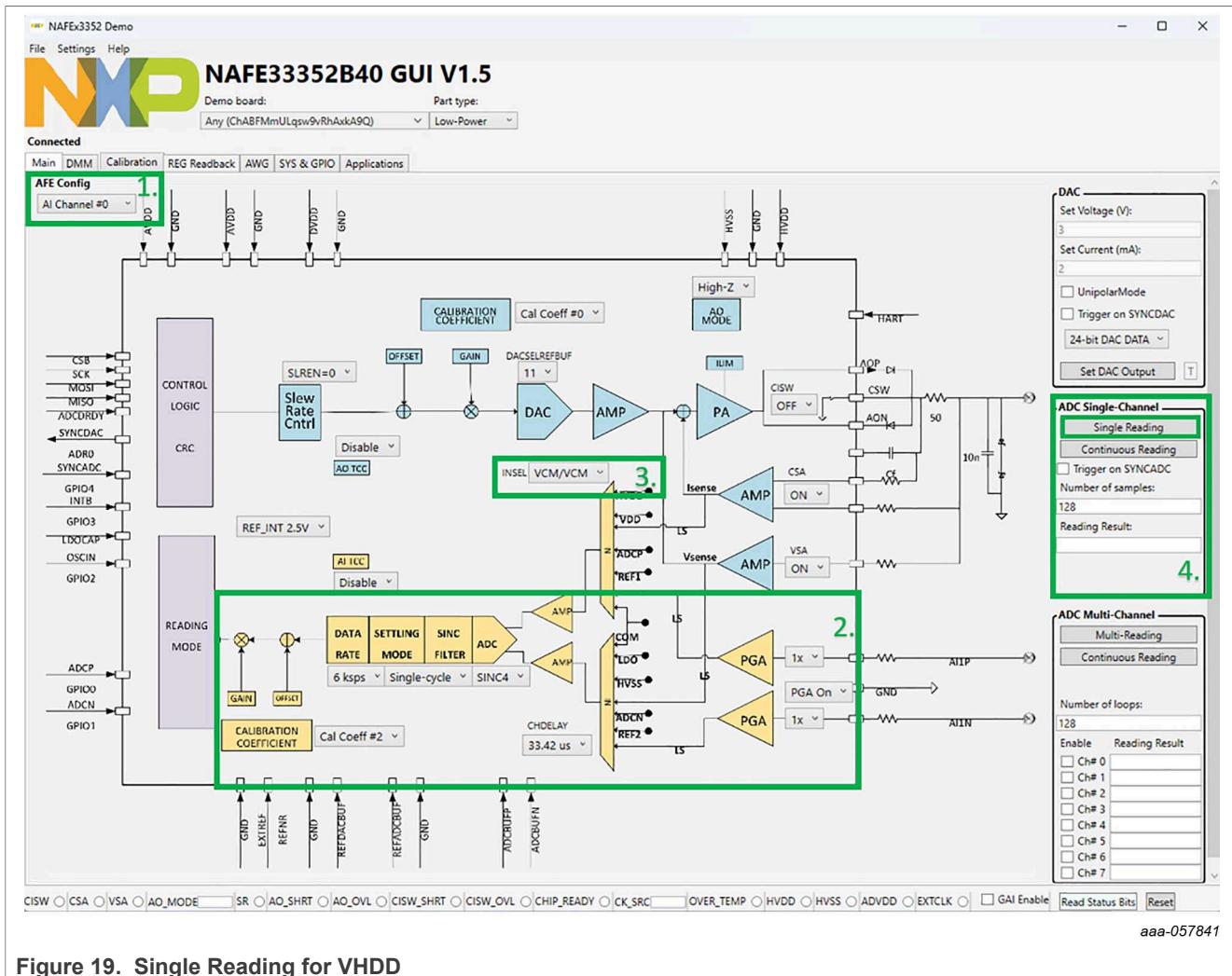


Figure 19. Single Reading for VHDD

### 5.2.15 Single-channel continuous-reading (SCCR) example

Example: Channel#0 is configured to read the internal VHDD signal. [Figure 20](#)

The steps to follow are:

1. Select number of channel as AI Channel #0.
2. Select PGA, SINC FILTER, ADC SETTING MODE, ADC DATA RATE, CHANNEL PROGRAM DELAY, and CALIBRATION COEFFICIENT settings in the dropdown menus.
3. Set VHDD/VCM.
4. Set number of loops as 128 samples.
5. Click **Continuous Reading** and a box will open.
6. Choose where save the file in \*.csv format.
7. The result will be 128 samples.

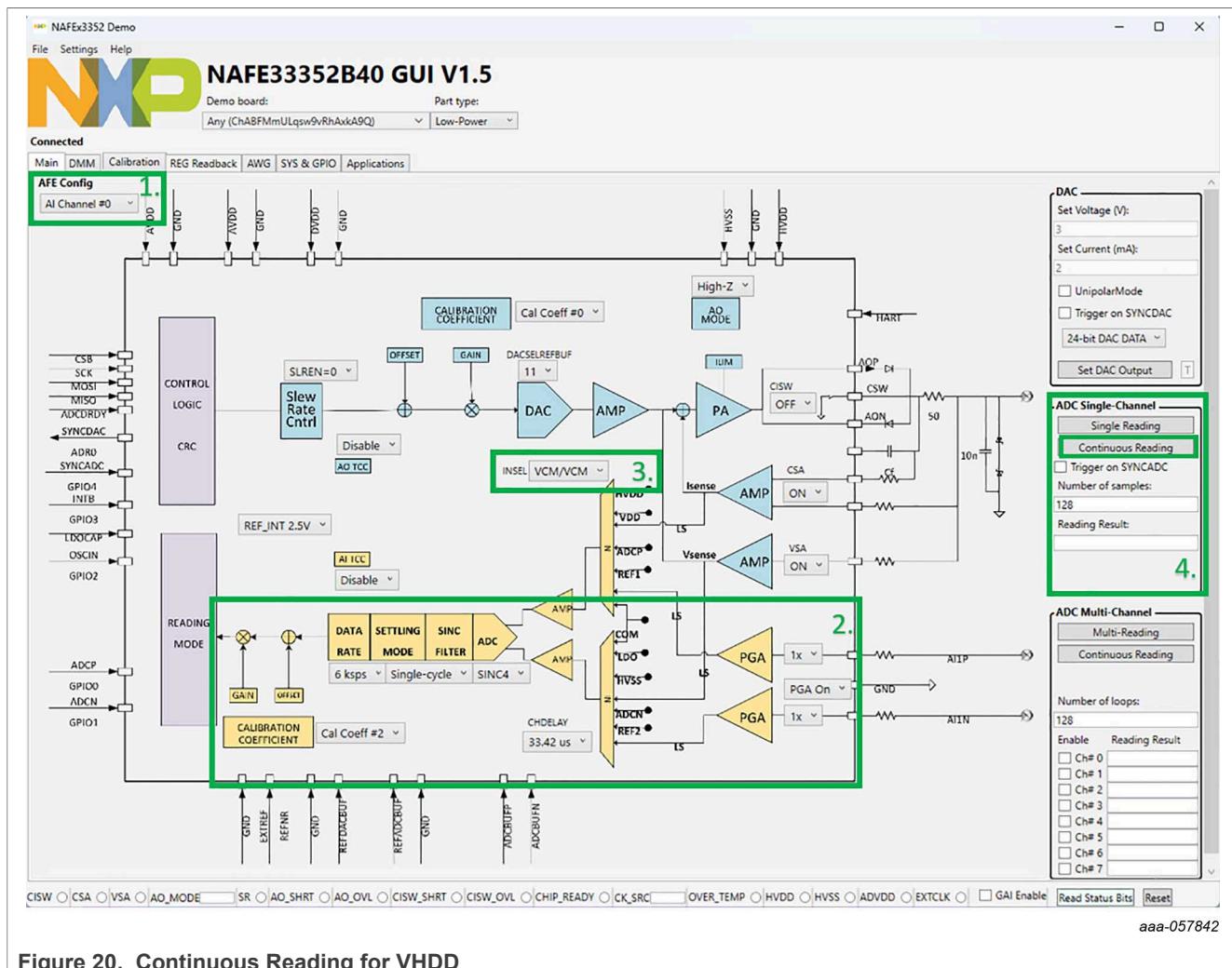


Figure 20. Continuous Reading for VHDD

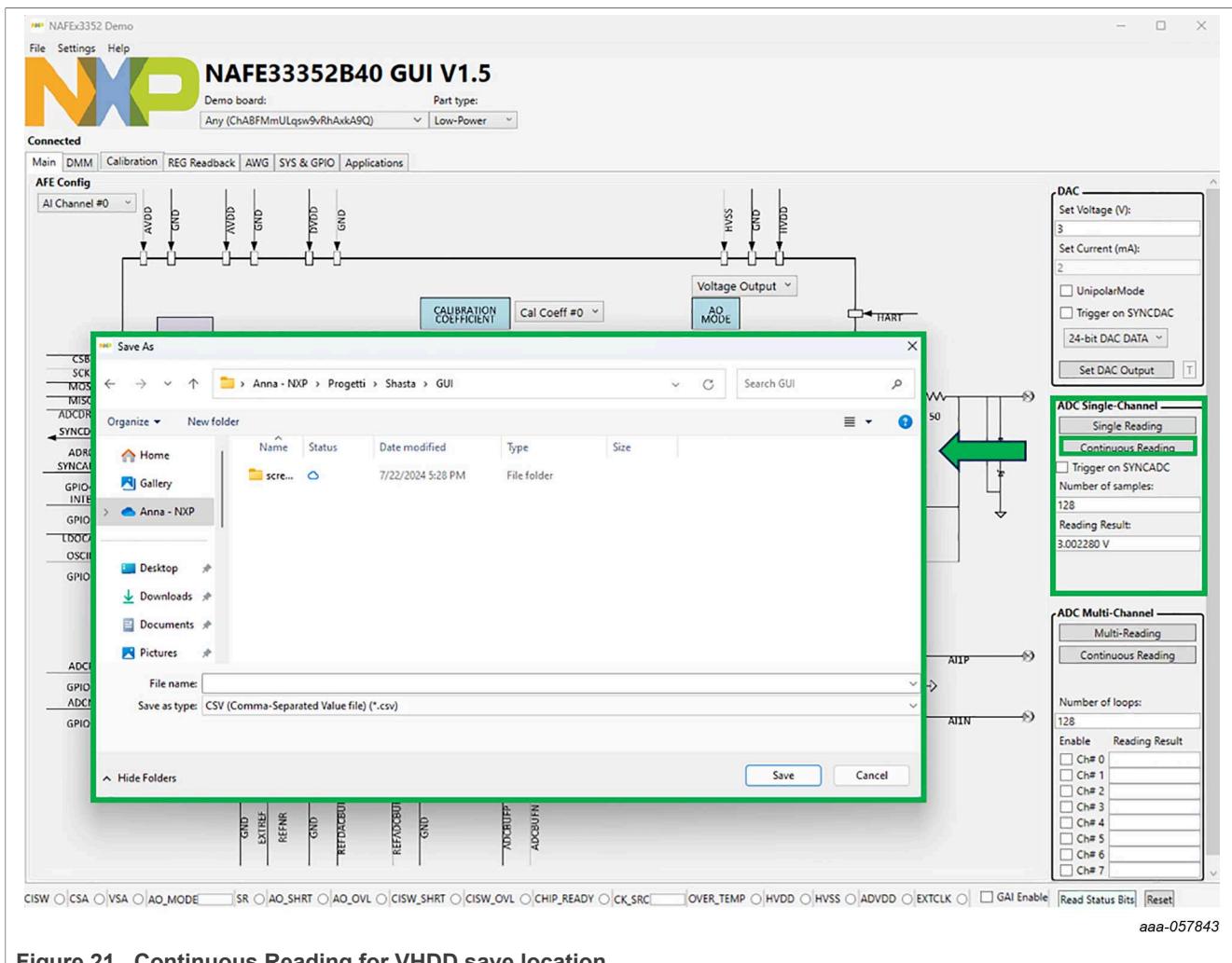


Figure 21. Continuous Reading for VHDD save location

### 5.2.16 Multichannel reading (MCR) example

Example: From Channel#0 to Channel#7 are configured to read VADD(ch0), HVDD(ch1), HVSS(ch2), REF\_BYP(ch3), GPIO0-1(ch4), AIP-VCM(ch5), VCM-AIN(ch6), LDO(ch7).

The steps to follow are:

1. Select number of channel as AI Channel #0.
2. Select PGA, SINC FILTER, ADC SETTING MODE, ADC DATA RATE, CHANNEL PROGRAM DELAY, and CALIBRATION COEFFICIENT settings in the dropdown menus.
3. Set VADD/VCM.
4. Set number of loops as 128 samples.
5. Repeat steps 1-3 for the channels that are need.
6. Click **Multi-Reading**.
7. The result will report for all channels.

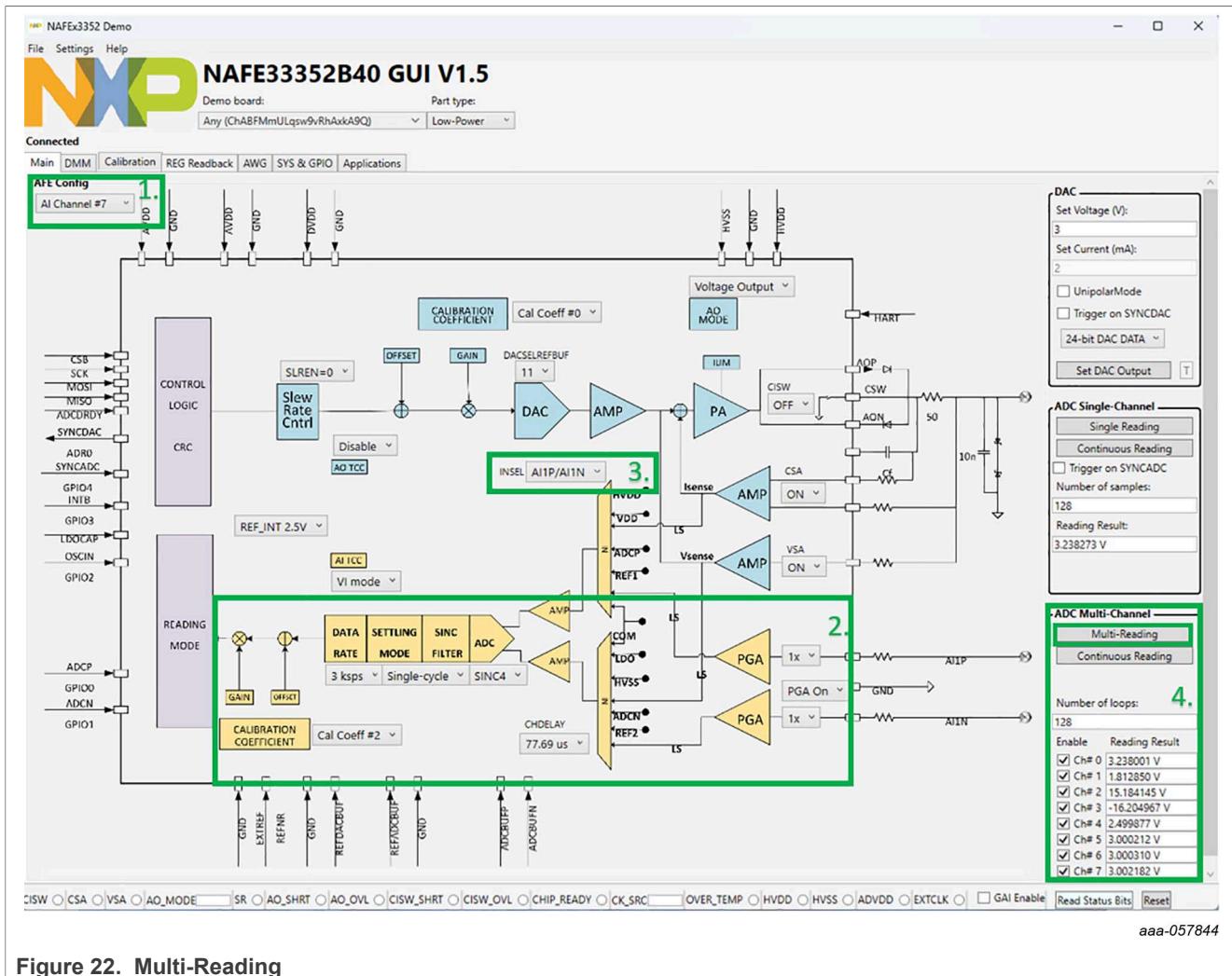


Figure 22. Multi-Reading

### 5.2.17 Multichannel continuous-reading (MCCR) example

Example: From Channel#0 to Channel#7 are configured to read the internal VHDD signal VADD, HVDD, HVSS, REF\_BYP, GPIO0-1, AIP-VCM, VCM-AIN, LDO. (Figure 25).

The steps to follow that are:

1. Select number of channel as AI Channel #0
2. Select PGA, SINC FILTER, ADC SETTING MODE, ADC DATA RATE, CHANNEL PROGRAM DELAY, and CALIBRATION COEFFICIENT settings in the dropdown menus.
3. Set VADD /VCM
4. Set number of loops as 128 samples.
5. Repeat steps 1-3 for the channels that are need
6. Click **Continuous Reading**.
7. Choose where save the file in \*.csv format.
8. The results will be 128 samples.

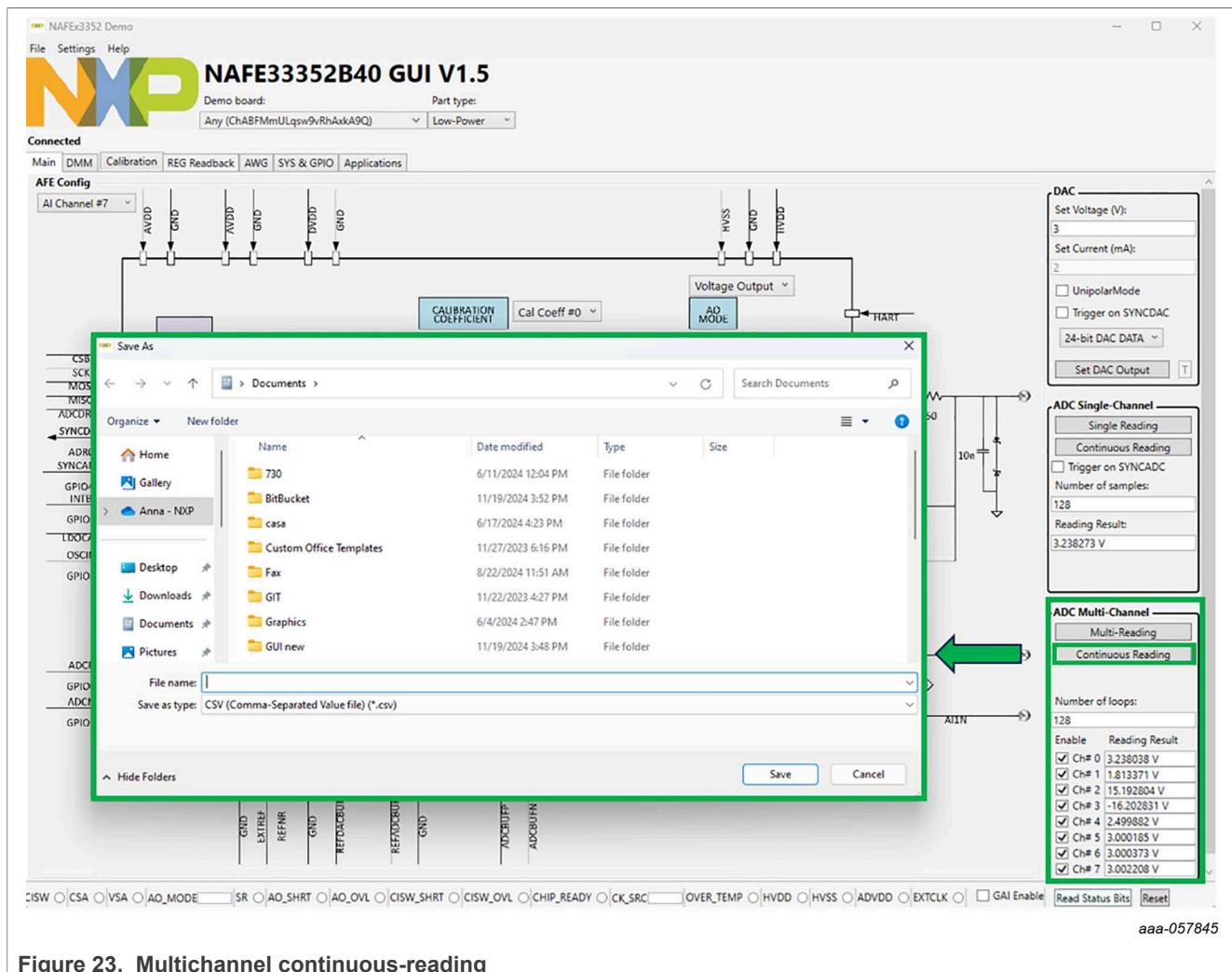


Figure 23. Multichannel continuous-reading

Figure 24 shows the structure of the csv file, the number of saved channels, and for each channel, the reported voltage measurement with 128 samples (128 rows).

NAExxx352 Continuous Reading.csv - Saved to this PC																														
File	Page Layout	View	Automate	Help	Search	Comments	Share																							
Sample	Ch #	Timestamp	Value	(Value (d))	Timestamp	Value	(Value (d))	Timestamp	Value	(Value (d))	Timestamp	Value	(Value (d))	Timestamp	Value	(Value (d))	Timestamp	Value	(Value (d))	Timestamp	Value	(Value (d))								
1	4	2009.7	48592	3.23188	2	611.11	187744	160402	15.29123	1628317	15.527	3	4312.16	001517	-118920.9	2.50118	4	1841.18	FD0089	-19437	-0.0643	5	225.21	001000AE						
2	4	3277.44	07124AC	486082	3.23292	3	3668.37	187462	160404	19.28979	16099	3.07685	6	1450.42	001517	-118895	2.50132	7	492.44	1A4	000888	-194424	8	5312.47	000FAF					
3	4	6154.4	7765B	48594	3.23196	7	6765.93	187474	160405	15.30096	2.7165	7.624FE	8	1620.90	001517	-118930	15.537	9	7357.67	001516	-118896	2.50119	10	7987.7	FD0089	-194375	-0.0643	11	8409.7	000707A
4	5	9431.86	07760E	485974	3.23161	12	9842.88	187479	160407	24.29929	2.10253	2.9140	13	1064.63	001517	-118879	2.50134	14	1107.95	FD0089	-194384	-0.0643	15	11468.9	0008B5					
5	6	12509.11	7765E	485917	3.23263	16	12920.14	187E99	160533	15.30884	162936	15.5262	17	13311.6	2.7234E	160408	2.72223	18	13742.19	001517	-118917	2.50115	19	1415.31	2.72121	-194372	-0.0643	20	15454.24	0000B7
6	7	15586.37	77480	485876	3.23271	21	15997.74	187E0D	160541	15.30973	160408	4.02223	22	1640.42	2.72218	160265	15.5414	23	16181.44	001517	-118895	2.50119	24	1723.04	001507	-194084	-0.0643	25	17614.9	000940AO
7	8	18663.63	07757E	48883	3.23209	26	19074.65	187DDE	160568	15.30729	162945	15.5247	27	1948.65	2.72184	160272	15.5247	28	19896.7	001528	-118885	2.50123	29	2030.77	FD0089	-194413	-0.0643	30	20718.75	0000AC
8	9	21740.89	77523	485793	3.231049	31	22151.91	188122	160592	15.31527	2.2562.93	7.91FC	32	160307	15.5473	2.2562.93	7.91FC	33	2297.96	001518	-118865	2.50136	34	2338.98	FD0083	-194433	-0.0643	35	23796.01	0000B6
9	10	24818.17	77484	485876	3.23297	36	2522.17	188046	160570	15.31317	2.2564.01	7.72157	37	162985	15.5436	2.2605.12	2.00152	38	2.5642.24	FD0088	-194379	-0.0643	39	2673.62	0000AA					
10	11	27895.4	77423	485843	3.23297	40	28306.42	187E64	160578	15.30893	2.2871.75	7.72E3	41	162926	15.5373	2.2912.47	2.00152	42	2.5935.9	FD0080	-194352	-0.0643	43	2995.02	00052C8					
11	12	30972.66	77423	48794	3.23268	44	34460.94	187997	160599	15.29655	2.3487.96	7.72715	45	162835	15.5296	3.3528.99	001517	46	3.5691.01	FD0089	-194403	-0.0643	47	3.6105.03	0003EEA					
12	13	34049.91	07749D	48884	3.23295	48	37538.86	1875C8	160649	15.30316	2.3794.25	7.72509	49	162821	15.5288	3.4561.76	2.001510	50	3.6774.3	FD0084	-194463	-0.0643	51	3.7037.7	000085					
13	14	37112.17	07740D	48844	3.23216	52	40494.45	1875D9	160649	15.30282	2.4041.25	7.72509	53	162912	15.5279	4.4036.24	2.001511	54	3.8777.0	FD0083	-194403	-0.0643	55	4.2255.45	0000D3					
14	15	40494.45	77423	48844	3.23295	56	4338.81	187581	160649	15.30282	2.4338.81	7.72509	57	162901	15.5279	4.4414.76	2.001510	58	4.4925.79	FD0084	-194377	-0.0643	59	4.5259.45	0000D3					
15	16	4338.81	77376	485881	3.23244	60	4679.71	187A09	1606411	15.3098	2.4410.73	7.72649	61	162899	15.5306	4.4514.76	2.001510	62	4.4925.79	FD0084	-194380	-0.0643	63	4.5316.81	000109D					
16	17	4679.71	77136	488214	3.23279	64	46769.71	187C18	1606432	15.30296	2.4710.89	7.72518	65	162901	15.53044	3.4759.01	2.001479	66	4.0003.04	FD0084	-194389	-0.0643	67	4.8410.44	000109D					
17	18	49434.2	77708	485924	3.23238	68	4987.22	187C58	1605805	15.30461	2.5035.24	7.54289	69	162906	15.5363	5.0668.27	2.001515	70	4.5108.02	FD0082	-194182	-0.0643	71	5.1591.23	0000B5					
18	19	52513.15	774411	488683	3.23201	72	52504.38	187B18	160400	15.30266	2.5335.5	7.542FA4	73	162934	15.53347	3.5747.65	2.001511	74	5.4157.55	FD0084	-194400	-0.0643	75	5.4568.58	0000A7					
19	20	55590.71	07752D	48881	3.23215	76	56001.74	187E42	160510	15.30762	2.5612.76	7.72736	77	162928	15.53381	3.5821.62	2.001510	78	5.7234.81	FD0084	-194385	-0.0643	79	5.7645.83	0000B8E					
20	21	58667.97	77419	48847	3.23292	80	5907.98	187ECD	1605325	15.30957	2.5849.02	7.72220	81	162925	15.53045	3.5990.14	2.001510	82	6.0112.07	FD0084	-194387	-0.0643	83	6.0723.09	0000A5					
21	22	61745.23	77423	48573	3.23305	84	6215.26	187998	1605109	15.30665	2.6257.27	7.72090	85	162940	15.53140	3.6297.73	2.001510	86	6.3385.32	FD0084	-194394	-0.0643	87	6.3800.35	0000CC					
22	23	64822.48	077B18	488372	3.232874	88	65233.51	188131	1605937	15.31541	2.65644.52	7.72070	89	162903	15.53045	3.6605.56	2.001510	90	6.4464.58	FD0084	-194418	-0.0643	91	6.6677.6	0000B8E					
23	24	67899.74	77436	485850	3.232936	92	6813.82	187E66	1605106	15.30996	2.6872.71	7.72090	93	162998	15.53449	3.6912.81	2.001510	94	6.9554.84	FD0084	-194387	-0.0643	95	6.9954.86	0000B8E					
24	25	70977.77298	48809	3.23274	96	71388.02	1.87E+40	160576	15.30815	2.71799.05	7.72200	97	162996	15.53442	3.72210.07	2.001524	98	7.2621.09	FD0082	-194382	-0.0643	99	7.3032.12	0000C2CA						
25	26	74054.25	77238	485823	3.232807	100	74465.28	187C66	1604710	15.30371	2.7487.63	7.7234F	101	162931	15.53388	3.75287.33	0014FC	102	8.48892	2.501311	-194379	-0.0643	103	7.6019.38	0000C2Z					
26	27	77131.51	0772A6	48810	3.232375	104	77543.53	187B3A	1604532	15.30191	2.7753.56	7.72427	105	162915	15.53457	3.78334.58	001502	106	7.7577.61	FD0084	-194387	-0.0643	107	7.9186.63	0000D002					
27	28	80208.77	77403	485843	3.23292	108	83695.08	187A97	1604204	15.29975	2.81030.82	7.58286	109	162886	15.53333	3.8441.84	2.001510	110	8.1852.86	FD0088	-194352	-0.0643	111	8.2263.89	0000B8Z					
28	29	83266.02	77404	48845	3.23292	112	83695.08	1.88E+09	1604070	15.29796	2.8410.87	7.6241	113	162867	15.53316	3.8840.77	2.001510	114	8.4930.12	FD0084	-194395	-0.0643	115	8.5313.85	001500AF					
29	30	86384.28	077D1E	48884	3.23294	116	86374.73	187A83	1604207	15.29799	2.8785.33	7.72872	117	162837.2	15.53326	3.8735.99	2.001510	118	8.8099.12	FD0084	-194385	-0.0643	119	8.8444.66	0000B8E					
30	31	90251.87	77423	48836	3.23297	120	90251.87	187B27	1604909	15.29949	2.8934.89	7.72750	121	162854	15.53254	3.9179.87	001502	122	9.4161.89	FD0089	-194371	-0.0643	123	9.4572.92	0000A444					
31	32	93515.05	0774AF	48836	3.232031	124	90606.06	187B08	1604896	15.29886	2.9041.76	7.72656	125	162856	15.53255	3.9632.81	2.001510	126	9.4576.15	FD0089	-194402	-0.0643	127	9.5765.17	0000B8E					
32	33	96455.05	77408	48840	3.232889	128	99083.33	187C5A	1604038	15.29881	2.9943.64	7.57545	129	162861	15.53344	3.9904.36	2.001510	130	10.0316.4	FD0084	-194390	-0.0643	131	10.0727.44	0000C101					
33	34	98672.21	077103	48840	3.232889	132	99083.33	187C5A	1604038	15.29881	2.9943.64	7.57545	133	162861	15.53344	3.9904.36	2.001510	134	10.0316.4	FD0084	-194390	-0.0643	135	10.0727.44	0000C101					
34	35	101249.6	77208	48884	3.232891	136	102537.15	187D92	1604612	15.30087	2.10251.6	7.52408	137	162861	15.53363	3.10251.6	2.001510	138	10.3932.7	FD0084	-194385	-0.0643	139	10.3904.7	0000B8E					
35	36	104826.83	77243	48845	3.232927	140	105237.15	187D92	1604510	15.30087	2.10548.5	7.5243.57	141	162859	15.53363	3.10605.9	2.001510	142	10.4670.59	FD0089	-194401	-0.0643	143	10.5681.9	0000B8E					
36	37	107904.15	0774ED	48884	3.232033	144	108315.12	187D92	1604905	15.30357	2.10872.6	7.52396	145	162886	15.53319	3.10912.73	2.001510	146	10.9582.4	FD0082	-194350	-0.0643	147	10.9959.2	0000A270					
37	38	10981.93	77440	48851	3.232941	149	111392.14	187B26	1604988	15.30317	2.11803.4	7.6245	150	162884	15.53444	3.11224.4	2.001510	151	10.9589.1	FD0089	-194335	-0.0643	152	11.0316.5	0000C099					
38	39	114058.6	077938	48847	3.232862	154	114469.6	187BFB	1605057	15.31188	2.11880.6	7.6276	155	162876	15.54246	3.11529.7	2.001510	156	11.5702.4	FD0087	-194353	-0.0643	157	11.6113.7	0000B8E					
39	40	117135.9	77307	48819	3.232081	158	117549.6	188041	1605097	15.31312	2.11795.7	7.62547	159	162880	15.54347	3.11386.8	2.001510	160	11.7870.5	FD0089	-194361	-0.0643	161	11.9511.0000AB						
40	41	12021.11	2.7713	48877	3.232064	162	12026.1	187E02	1605098																					

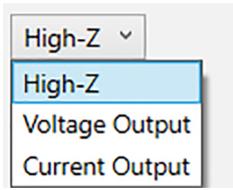
**Figure 24. Continuous-reading in .csv format**

### 5.2.18 DAC analog output

The DAC has AIO mode selection.

The user can choose as AIO mode:

- High-Z
- Voltage Output
- Current Output



**Figure 25. AIO mode**

When AIO mode is selected high-Z, set Voltage and set Current controls are disabled. The DACSELREFBUF should be 11 to enable Analog Output operation.

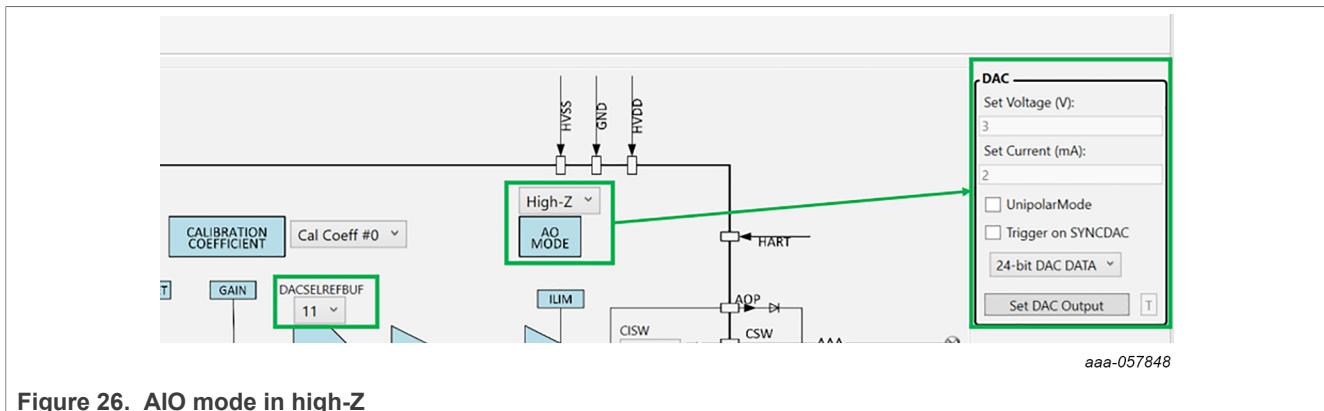


Figure 26. AIO mode in high-Z

### 5.2.18.1 Voltage output

Figure 27 shows the analog output set for Voltage Output (VO) mode:

1. Set Channel.
2. Set DAC equal to 11.
3. Set as insel VCM/VNS.
4. Set AIO mode to Voltage Output.
5. Set voltage to 3 V (limit range  $\pm 12.5$  V).
6. Readback SCSR or SCCR

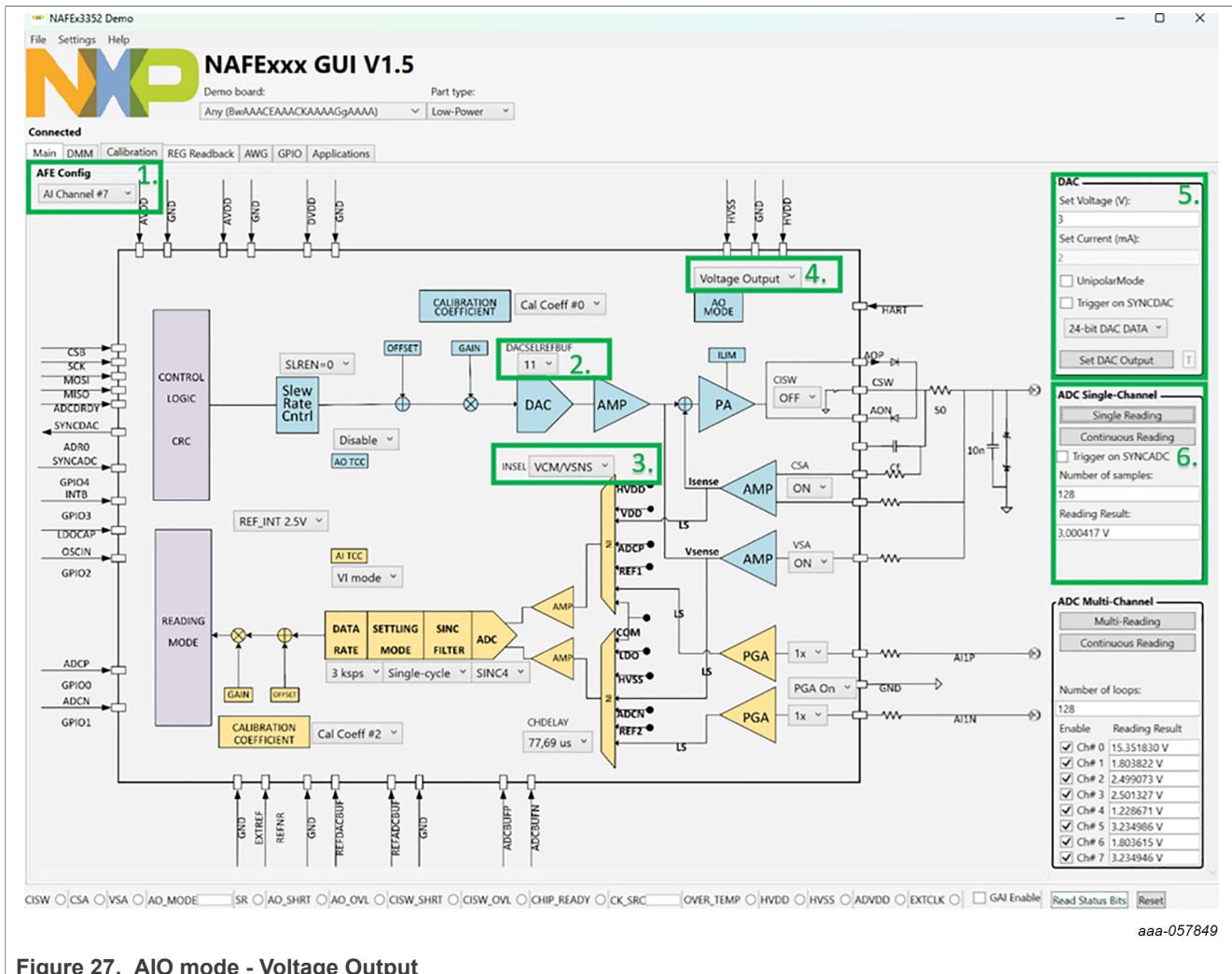


Figure 27. AIO mode - Voltage Output

### 5.2.18.2 Current output

Figure 28 shows the analog output set for Current Output (CO) mode:

1. Set Channel
2. Put DAC equal to 11
3. Set as insel INSNS/VCM
4. Set AIO MODE to Current Output
5. Set Current to 20mA(limit range  $\pm 25$ mA)
6. Readback SCSR or SCCR

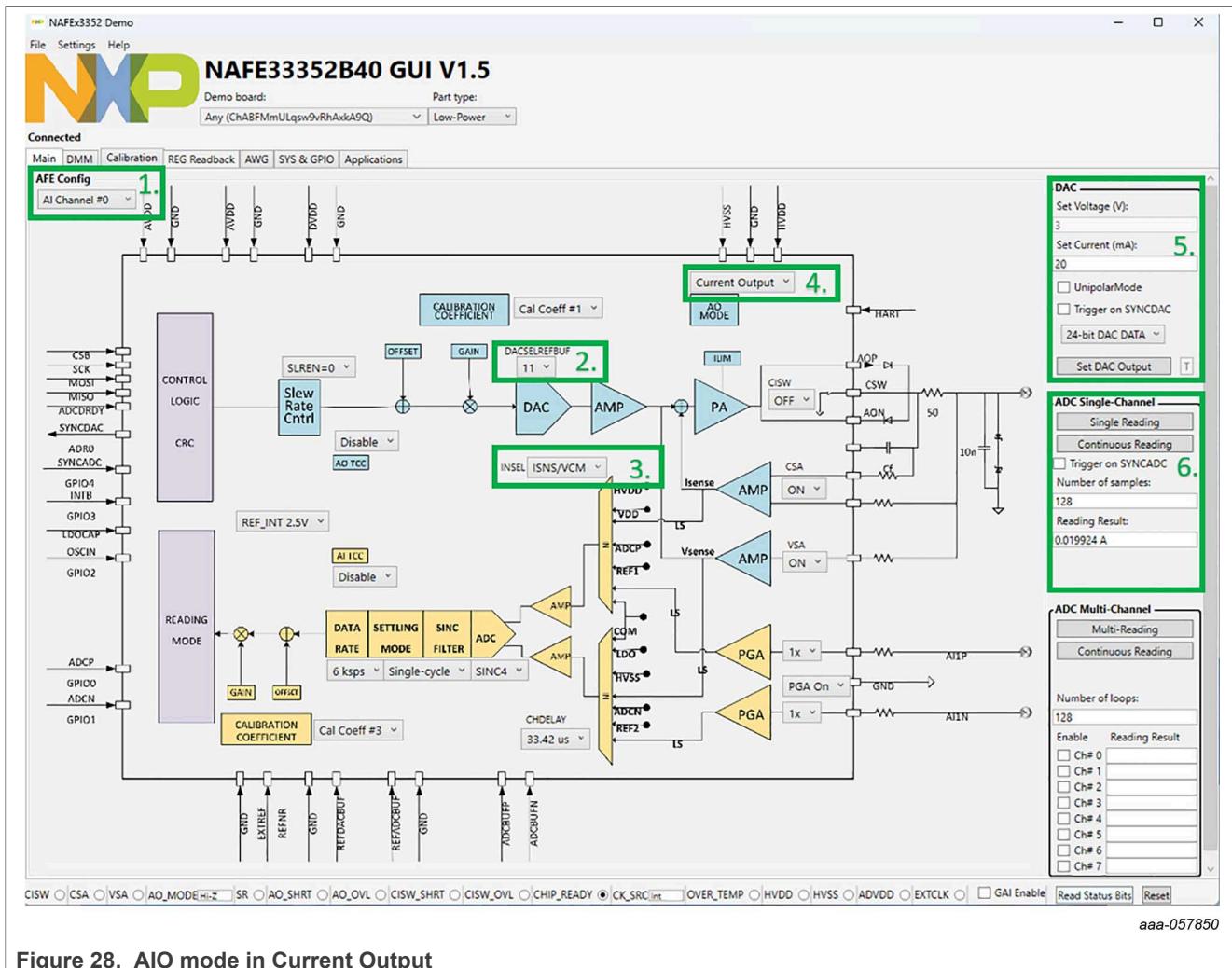


Figure 28. AIO mode in Current Output

### 5.2.19 Save and load configuration file

The NAFExx3352 GUI provides a user-friendly save-and-load configuration file function. This function allows the user to save current AFE channel (#0-8) configurations, SCCR number of samples, MCCR enabled channel, and MCCR number of loops in an .acs (AFE configuration settings) file. The user can load a previously saved .acs configuration file to load all configuration settings into the GUI without the need to manually change every setting one by one in the GUI.

#### 5.2.19.1 Save configuration file

First, launch the NAFExx3352 GUI, select all configuration settings (AFE channel #0-8 configuration settings, SCR/SCCR/MCR/MCCR settings), and proceed to the particular measurement or calibration. If the test result is as expected, the user can select Save AFE configuration in the File tab in the NAFExx3352 GUI as shown in Figure 29.



Figure 29. Save configuration

Second, key in a file name (such as test1\_save.acs) to save the particular measurement configuration settings in an .acs file to be used for future measurement.

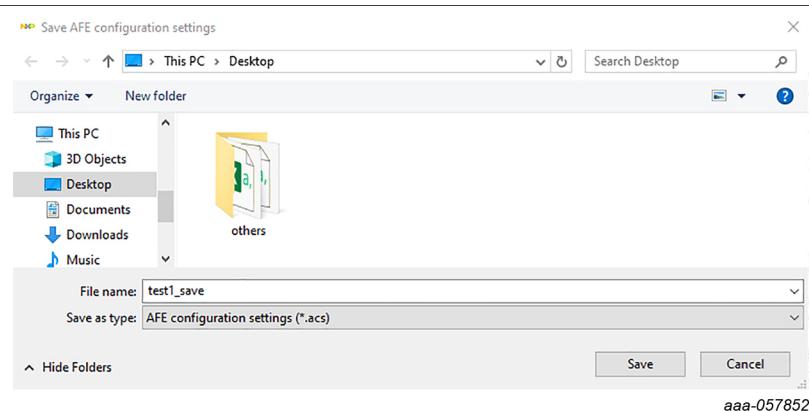


Figure 30. Example save file

### 5.2.19.2 Load configuration file

To launch the NAFExx3352 GUI, select **Open AFE configuration** in the File tab.

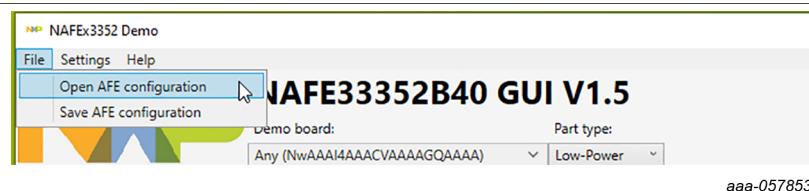


Figure 31. Open AFE configuration

Open the saved .acs file to load all configuration settings and proceed, repeating the previous measurement or modifying some settings for a new measurement.

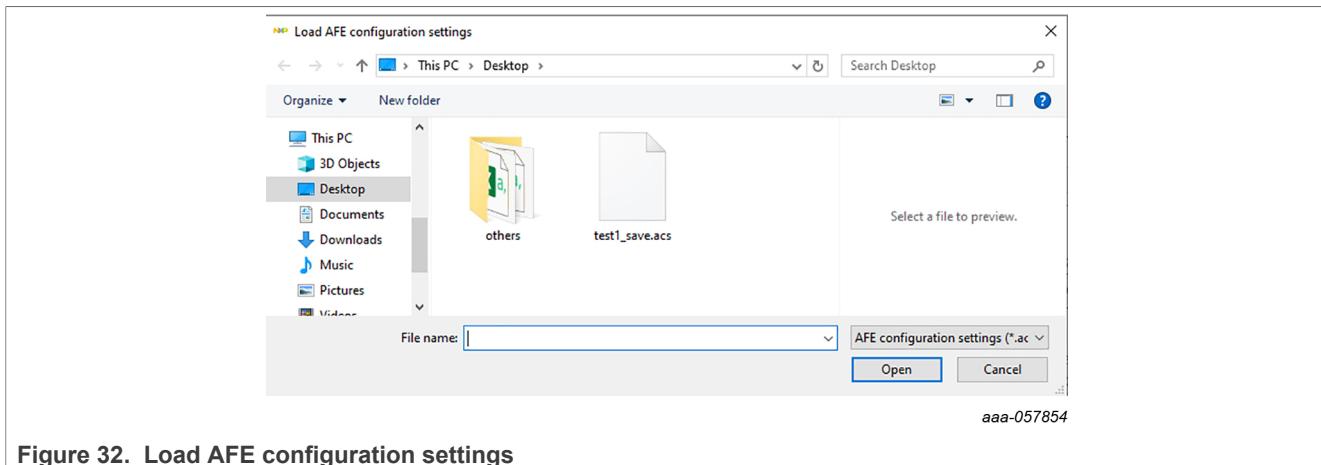


Figure 32. Load AFE configuration settings

### 5.3 Application demo

In the GUI, it is possible to try four typical applications of the NAFE, divided into the following subtabs:

- On Board RTD
- External 4W PT100
- Load Cell
- Input Current

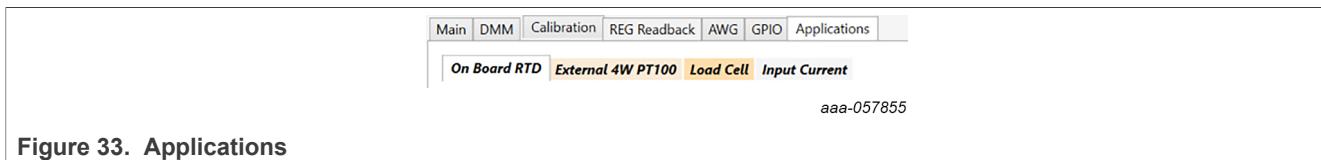


Figure 33. Applications

### 5.3.1 On Board RTD

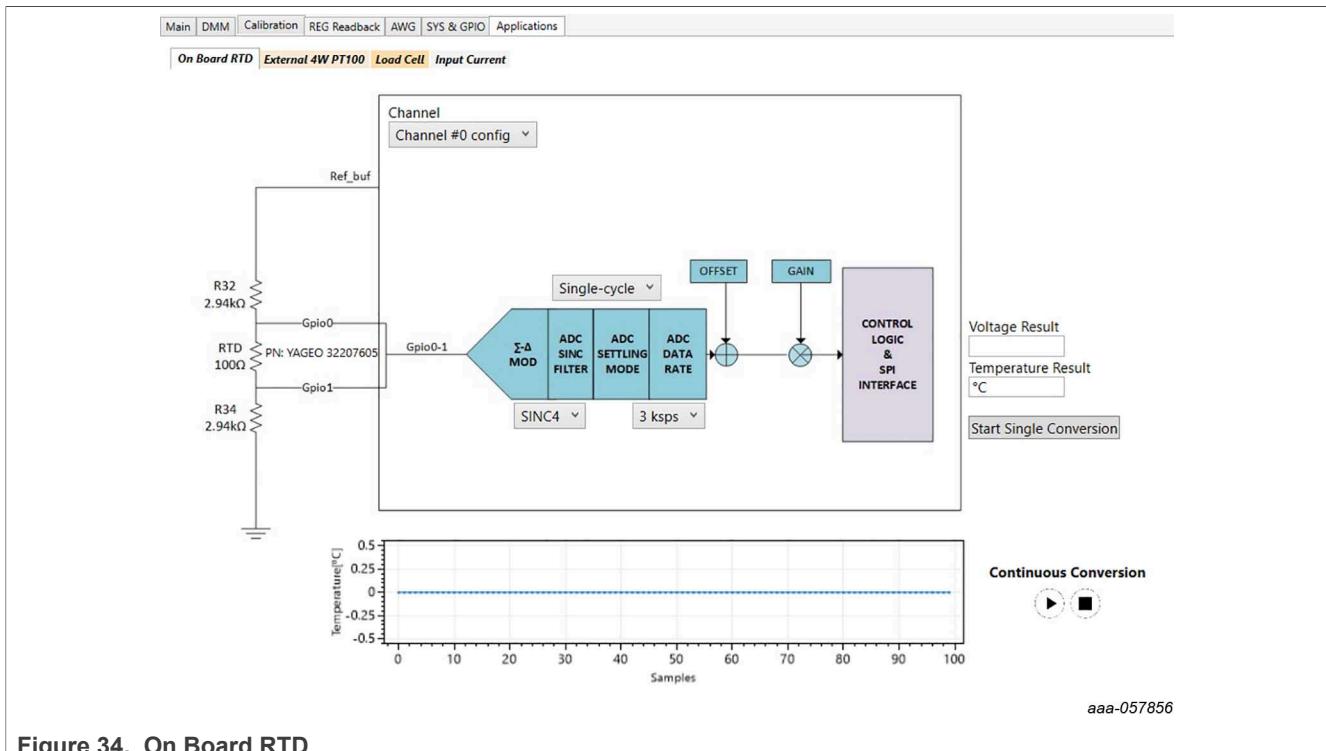


Figure 34. On Board RTD

The EVKit features a voltage divider composed of two resistors and one thermistor. The voltage divider is powered by ref\_buf output, as shown in the left portion of [Figure 34](#).

In this section, it is possible to configure only:

- SINC filter
- Single/Normal-cycle
- Data rate

Pressing ► (Play) below **Start Single Conversion** will execute a single conversion.

Two results will be shown:

- Voltage raw result
- Temperature conversion

At the bottom side of the tab, there is a chart and two buttons: ► and ■ (Stop). By pressing ►, a continuous conversion will be performed until ■ is pressed. The continuous conversion is configured to make 100 samples at a time. These samples will be plotted on the chart.



Figure 35. Continuous conversion warning

It is not possible to set slow rates too slow if Continuous mode is used. A warning message will appear below the continuous conversion buttons as shown in [Figure 35](#).

### 5.3.2 External 4 W PT100

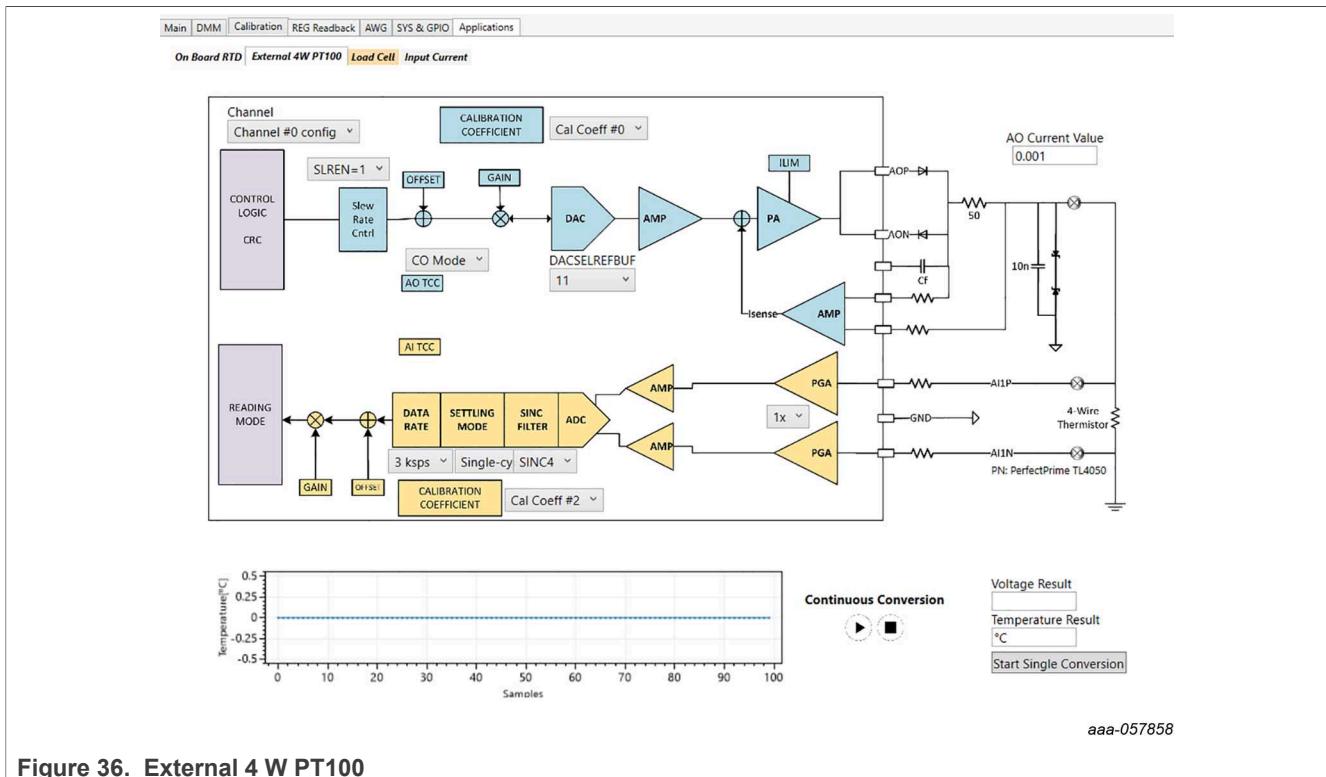


Figure 36. External 4 W PT100

PT 100 temperature sensors are the most common type of platinum resistance thermometer. PT indicates the sensor is made from Platinum (Pt), 100 means, at 0 °C, the sensor has a resistance of 100 ohms ( $\Omega$ ). The fourwire configuration makes it possible to force a current through two wires and read the voltage on the other two wires. This allows the reading of voltage, eliminating the voltage drop because of the current.

In this section is possible to configure:

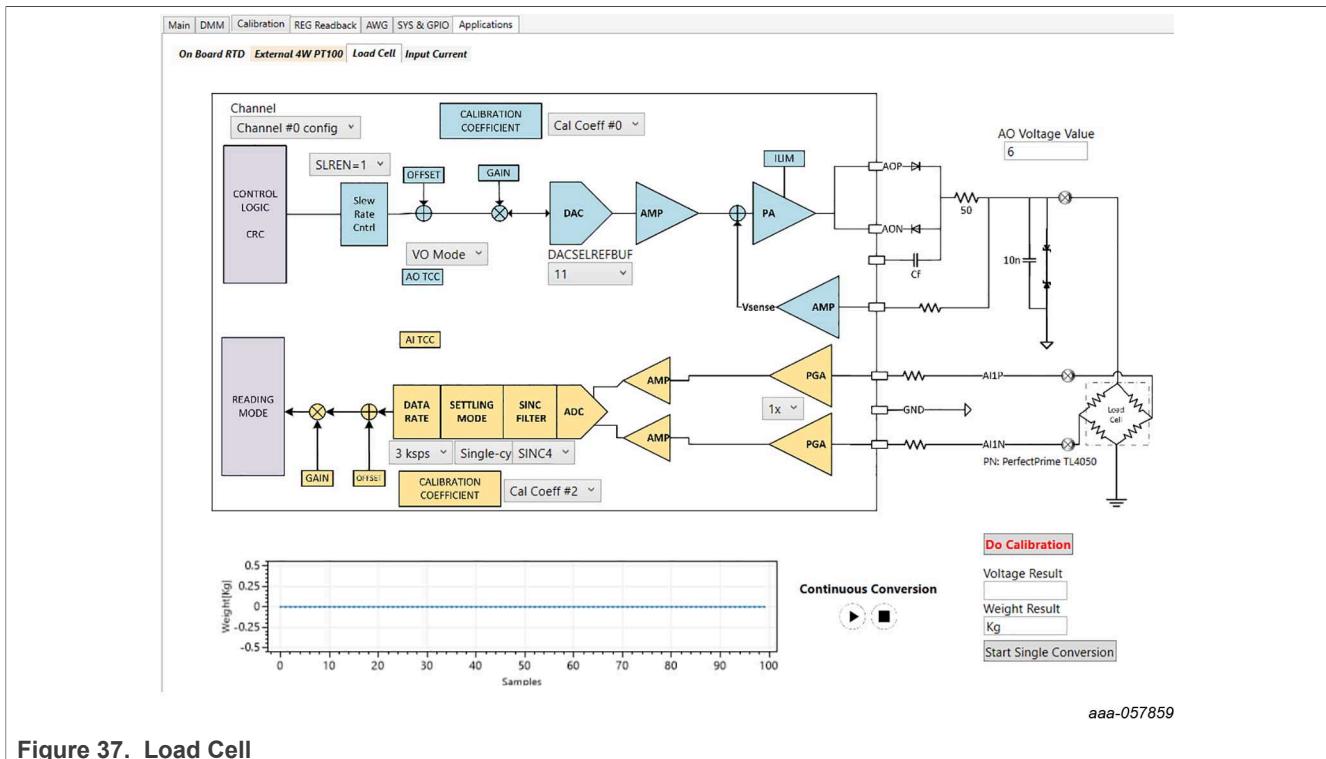
- Sinc filter
- Single/Normal-cycle
- Data rate
- Input pin (Sense)
- Output current pin (Force)
- Current magnitude
- Current sign

Pressing ► below **Start Single Conversion** will execute a single conversion. Two results will be shown:

- Voltage raw result
- Temperature conversion

At the bottom of the tab, there are a chart and two buttons: ► and ■. By pressing ►, a continuous conversion will be performed until ■ is pressed. The continuous conversion is configured to make 100 samples at a time. These sample will be plotted inside the chart.

### 5.3.3 Load Cell



**Figure 37. Load Cell**

The internal functioning of a load cell differs according to the load cell chosen. There are, for example, hydraulic load cells, pneumatic load cells, and strain-gauge load cells. As shown in [Figure 37](#), a strain-gauge load cell is used as an application example for NAFE33352.

In this section is possible to configure:

- Sinc filter
- Single/Normal-cycle
- Data rate
- Input pin (Sense)
- Output voltage pin (Force)
- Voltage magnitude
- Voltage sign

The voltage proportional to the force is small (a few mV), which is why it is recommended to use 16x PGA.

For this kind of conversion, a calibration is needed before starting. This is because the load cell structure transfer function depends on the structure where the load cell is mounted. The **Do Calibration** button, shown in [Figure 37](#), will be bold and red each time a calibration is needed. When this button is pressed, a dialog appears, as shown in [Figure 38](#).

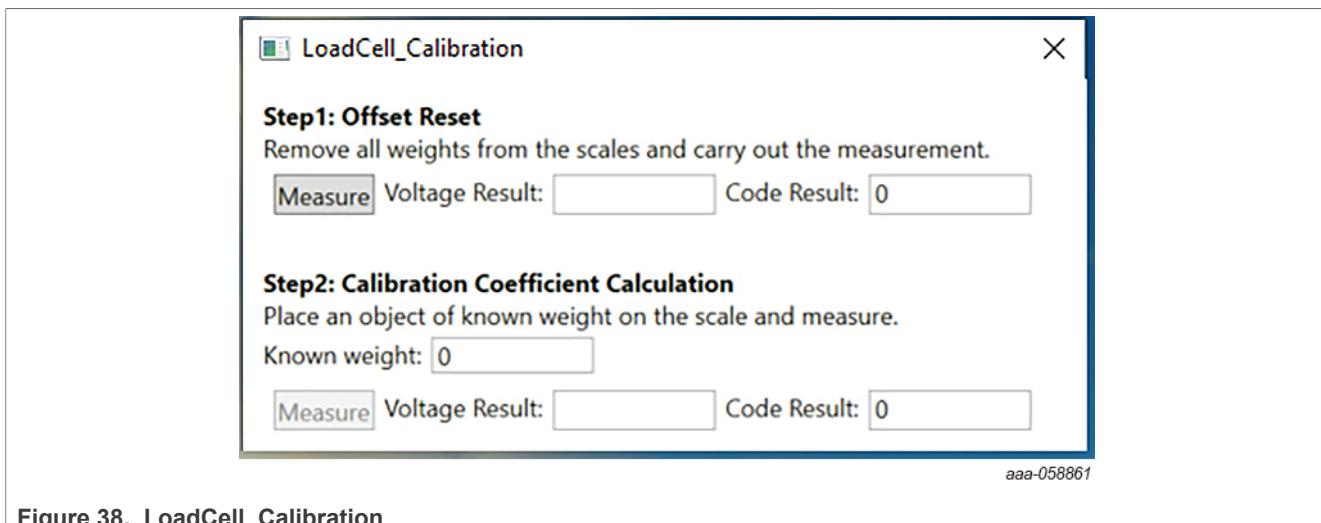
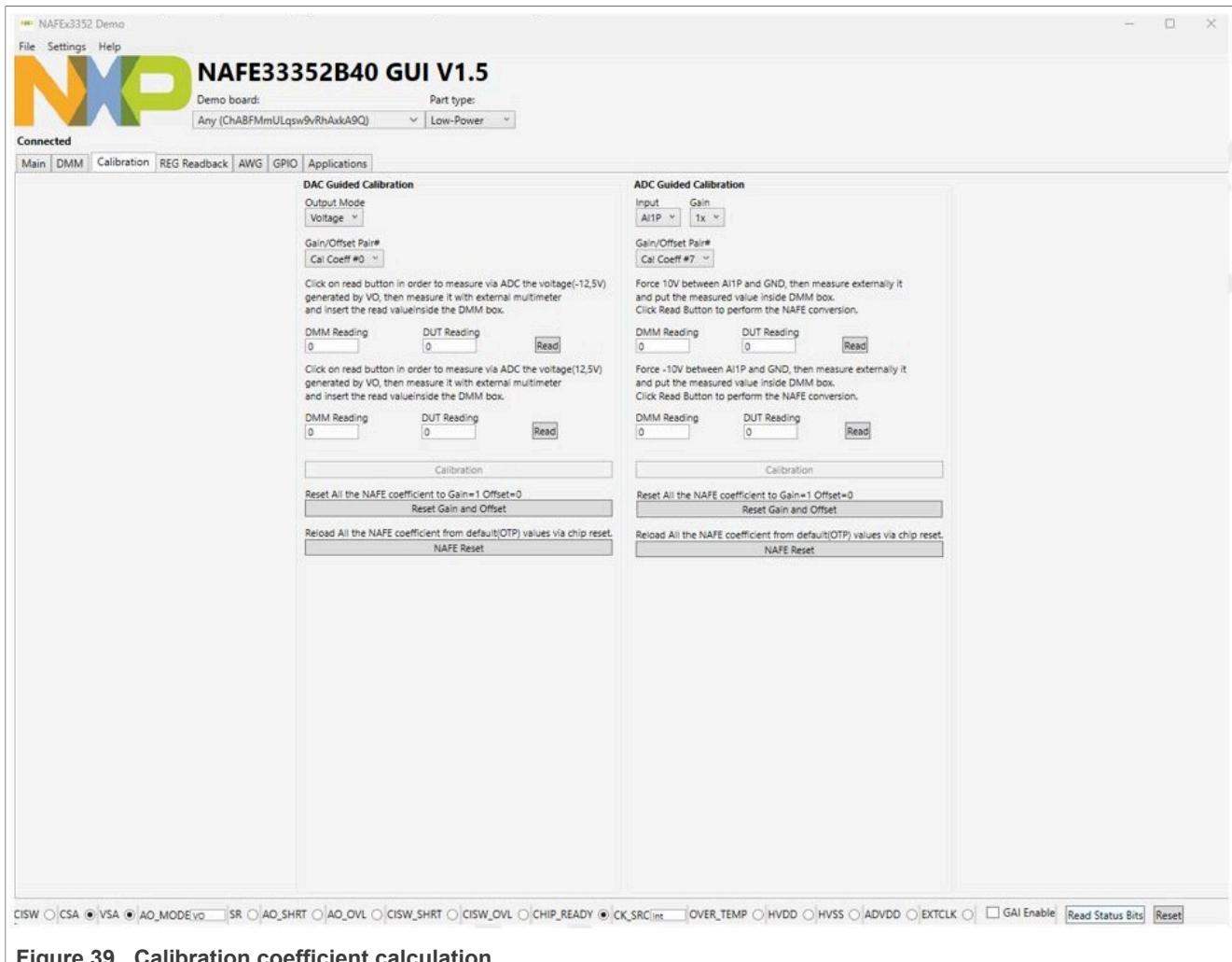


Figure 38. LoadCell\_Calibration

The calibration process consists of two steps (as shown in the pop-up dialogue window):

1. **Offset reset:** Remove all weight from the scale and take one measurement. This value will be the value at 0 load, therefore the system offset.
2. **Calibration coefficient calculation:** Place an object of known weight on the weight scale, write the known weight (unit kg) in the input box, and take a measurement.



**Figure 39. Calibration coefficient calculation**

These two measurements take about 4 to 5 seconds.

Pressing ► below **Start Single conversion** will execute a single conversion. Two results will be shown:

- Voltage raw result
- Temperature conversion

At the bottom of the tab, there is a chart and two buttons: ► and ■ (Stop). By pressing ►, a continuous conversion will be performed until ■ is pressed. The continuous conversion is configured to make 100 samples at a time. These sample will be plotted inside the chart.

### 5.3.4 Input Current

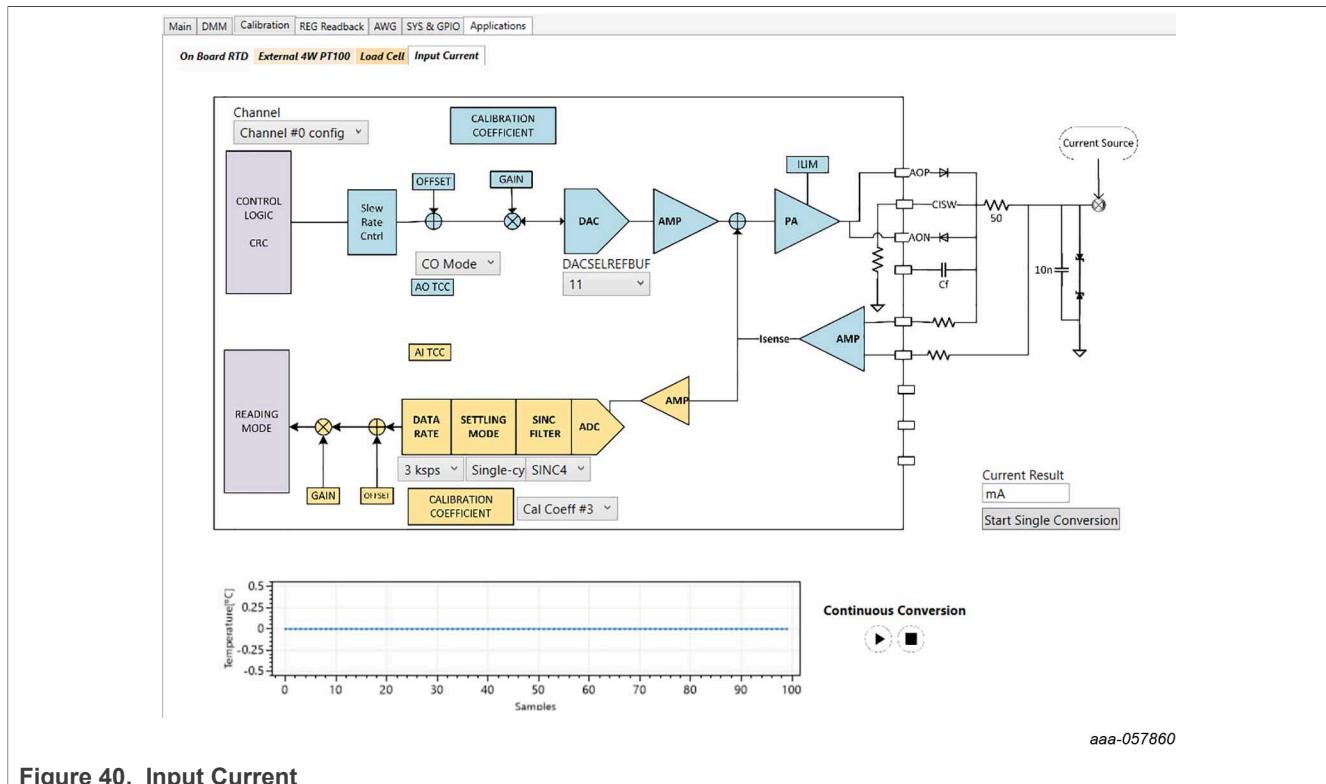


Figure 40. Input Current

In this section is possible to configure:

- Sinc filter
- Single/Normal-cycle
- Data rate
- Input pin (Sense)
- Output current pin (Force)

## 6 References

[1] **NAFE33352 schematic and jumper location** — See [NAFE33352\\_EVB\\_schematic.pdf](#).

[2] **NAFE33352 data sheet** — Product specification, function, and register map.

## 7 Revision history

Table 8. Revision history

Document ID	Release date	Description
UM12180 v.1.0	13 February 2025	Initial version

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